



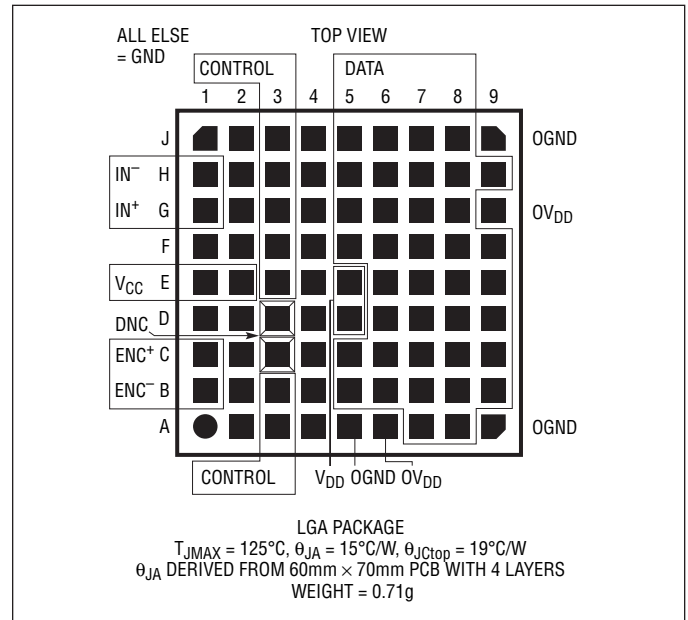
# LTM9001-Ax/LTM9001-Bx

## ABSOLUTE MAXIMUM RATINGS

(Notes 1, 2)

|                                             |                                      |
|---------------------------------------------|--------------------------------------|
| Supply Voltage ( $V_{CC}$ )                 | –0.3V to 3.6V                        |
| Supply Voltage ( $V_{DD}$ )                 | –0.3V to 4V                          |
| Digital Output Supply Voltage ( $OV_{DD}$ ) | –0.3V to 4V                          |
| Analog Input Current ( $IN^+$ , $IN^-$ )    | $\pm 10\text{mA}$                    |
| Digital Input Voltage<br>(Except AMPSHDN)   | –0.3V to ( $V_{DD} + 0.3\text{V}$ )  |
| Digital Input Voltage<br>(AMPSHDN)          | –0.3V to ( $V_{CC} + 0.3\text{V}$ )  |
| Digital Output Voltage                      | –0.3V to ( $OV_{DD} + 0.3\text{V}$ ) |
| Operating Temperature Range                 |                                      |
| LTM9001C                                    | 0°C to 70°C                          |
| LTM9001I                                    | –40°C to 85°C                        |
| Storage Temperature Range                   | –45°C to 125°C                       |
| Maximum Junction Temperature                | 125°C                                |

## PIN CONFIGURATION



## ORDER INFORMATION

| LEAD FREE FINISH | PART MARKING* | PACKAGE DESCRIPTION                     | TEMPERATURE RANGE |
|------------------|---------------|-----------------------------------------|-------------------|
| LTM9001CV-AA#PBF | LTM9001V-AA   | 81-Lead (11.25mm × 11.25mm × 2.3mm) LGA | 0°C to 70°C       |
| LTM9001IV-AA#PBF | LTM9001V-AA   | 81-Lead (11.25mm × 11.25mm × 2.3mm) LGA | –40°C to 85°C     |
| LTM9001CV-AD#PBF | LTM9001V-AD   | 81-Lead (11.25mm × 11.25mm × 2.3mm) LGA | 0°C to 70°C       |
| LTM9001IV-AD#PBF | LTM9001V-AD   | 81-Lead (11.25mm × 11.25mm × 2.3mm) LGA | –40°C to 85°C     |
| LTM9001CV-BA#PBF | LTM9001V-BA   | 81-Lead (11.25mm × 11.25mm × 2.3mm) LGA | 0°C to 70°C       |
| LTM9001IV-BA#PBF | LTM9001V-BA   | 81-Lead (11.25mm × 11.25mm × 2.3mm) LGA | –40°C to 85°C     |

Consult LTC Marketing for parts specified with wider operating temperature ranges. \*The temperature grade is identified by a label on the shipping container. Consult LTC Marketing for information on non-standard lead based finish parts.

For more information on lead free part marking, go to: <http://www.linear.com/leadfree/>

This product is only offered in trays. For more information go to: <http://www.linear.com/packaging/>

## ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T<sub>A</sub> = 25°C. (Note 4)

| SYMBOL            | PARAMETER              | CONDITIONS                                            | MIN    | TYP        | MAX  | UNITS    |
|-------------------|------------------------|-------------------------------------------------------|--------|------------|------|----------|
| G <sub>DIFF</sub> | Gain                   | DC, LTM9001-AA<br>f <sub>IN</sub> = 162.5MHz (Note 3) | ● 19.1 | 19.7<br>19 | 20.3 | dB<br>dB |
|                   |                        | DC, LTM9001-AD<br>f <sub>IN</sub> = 70MHz (Note 3)    | ● 13.4 | 14<br>13.5 | 14.7 | dB<br>dB |
|                   |                        | DC, LTM9001-BA<br>f <sub>IN</sub> = 140MHz (Note 3)   | ● 7.1  | 8.2<br>7.8 | 9.4  | dB<br>dB |
| G <sub>TEMP</sub> | Gain Temperature Drift | V <sub>IN</sub> = Maximum, (Note 3)                   |        | 2          |      | mdB/°C   |

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**ELECTRICAL CHARACTERISTICS**

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ . (Note 4)

| SYMBOL              | PARAMETER                                     | CONDITIONS                                                                                                                       | MIN                    | TYP               | MAX                  | UNITS                                                       |
|---------------------|-----------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------|------------------------|-------------------|----------------------|-------------------------------------------------------------|
| $V_{\text{INCM}}$   | Input Common Mode Voltage Range               | $(\text{IN}^+ + \text{IN}^-)/2$                                                                                                  |                        | 1.0–1.6           |                      | V                                                           |
| $V_{\text{IN}}$     | Input Voltage Range at –1dBFS                 | LTM9001-AA at 162.5MHz<br>LTM9001-AD at 70MHz<br>LTM9001-BA at 140MHz                                                            |                        | 233<br>424<br>820 |                      | mV <sub>P-P</sub><br>mV <sub>P-P</sub><br>mV <sub>P-P</sub> |
| $R_{\text{INDIFF}}$ | Differential Input Impedance                  | LTM9001-AA<br>LTM9001-AD<br>LTM9001-BA                                                                                           |                        | 200<br>200<br>400 |                      | $\Omega$<br>$\Omega$<br>$\Omega$                            |
| $C_{\text{INDIFF}}$ | Differential Input Capacitance                | Includes Parasitic                                                                                                               |                        | 1                 |                      | pF                                                          |
| $V_{\text{OS}}$     | Offset Error (Note 6)                         | Including Amplifier and ADC (LTM9001-AA)<br>Including Amplifier and ADC (LTM9001-AD)<br>Including Amplifier and ADC (LTM9001-BA) | ● –8<br>● –11<br>● –20 | –3.2<br>–6<br>–10 | –0.5<br>–0.5<br>–0.5 | mV<br>mV<br>mV                                              |
|                     | Offset Drift                                  | Including Amplifier and ADC                                                                                                      |                        | ±10               |                      | $\mu\text{V}/^\circ\text{C}$                                |
|                     | Full-Scale Drift                              | Internal Reference<br>External Reference                                                                                         |                        | ±30<br>±15        |                      | ppm/ $^\circ\text{C}$<br>ppm/ $^\circ\text{C}$              |
| CMRR                | Common Mode Rejection Ratio                   |                                                                                                                                  |                        | 60                |                      | dB                                                          |
| $I_{\text{SENSE}}$  | SENSE Input Leakage Current                   | $0\text{V} < \text{SENSE} < V_{\text{DD}}$                                                                                       | ● –3                   |                   | 3                    | $\mu\text{A}$                                               |
| $I_{\text{MODE}}$   | MODE Pin Pull-Down Current to GND             |                                                                                                                                  |                        | 10                |                      | $\mu\text{A}$                                               |
| $I_{\text{LVDS}}$   | LVDS Pin Pull-Down Current to GND             |                                                                                                                                  |                        | 10                |                      | $\mu\text{A}$                                               |
| $t_{\text{AP}}$     | Sample-and-Hold Acquisition Delay Time        |                                                                                                                                  |                        | 1                 |                      | ns                                                          |
| $t_{\text{JITTER}}$ | Sample-and-Hold Acquisition Delay Time Jitter |                                                                                                                                  |                        | 70                |                      | fs <sub>RMS</sub>                                           |

**CONVERTER CHARACTERISTICS**

The ● indicates specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ .

| PARAMETER                     | CONDITIONS                                                                               | MIN    | TYP  | MAX       | UNITS              |
|-------------------------------|------------------------------------------------------------------------------------------|--------|------|-----------|--------------------|
| Resolution (No Missing Codes) |                                                                                          | ● 16   |      |           | Bits               |
| Integral Linearity Error      | Differential Input LTM9001-Ax (Notes 5, 7)<br>Differential Input LTM9001-BA (Notes 5, 7) | ●<br>● | ±2.4 | ±8<br>±10 | LSB<br>LSB         |
| Differential Linearity Error  | Differential Input (Notes 5, 7)                                                          | ●      | ±0.3 | ±1        | LSB                |
| Transition Noise              | External Reference                                                                       |        | 1    |           | LSB <sub>RMS</sub> |

**DYNAMIC ACCURACY**

The ● indicates specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ .  $A_{\text{IN}} = -1\text{dBFS}$ . (Note 4)

| SYMBOL | PARAMETER             | CONDITIONS                                                                 | MIN    | TYP          | MAX | UNITS        |
|--------|-----------------------|----------------------------------------------------------------------------|--------|--------------|-----|--------------|
| SNR    | Signal-to-Noise Ratio | 162.5MHz Input (PGA = 0) LTM9001-AA<br>162.5MHz Input (PGA = 1) LTM9001-AA |        | 72<br>68.5   |     | dBFS<br>dBFS |
|        |                       | 70MHz Input (PGA = 0) LTM9001-AD<br>70MHz Input (PGA = 1) LTM9001-AD       | ● 71.2 | 75<br>72     |     | dBFS<br>dBFS |
|        |                       | 140MHz Input (PGA = 0) LTM9001-BA<br>140MHz Input (PGA = 1) LTM9001-BA     | ● 67   | 69.2<br>67.2 |     | dBFS<br>dBFS |

# LTM9001-Ax/LTM9001-Bx

**DYNAMIC ACCURACY** The ● indicates specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ .  $A_{IN} = -1\text{dBFS}$ . (Note 4)

| SYMBOL           | PARAMETER                                                                    | CONDITIONS                            | MIN    | TYP  | MAX | UNITS |
|------------------|------------------------------------------------------------------------------|---------------------------------------|--------|------|-----|-------|
| SFDR             | Spurious Free Dynamic Range, 2nd or 3rd Harmonic                             | 162.5MHz Input (PGA = 0) LTM9001-AA   |        | 78   |     | dBc   |
|                  |                                                                              | 162.5MHz Input (PGA = 1) LTM9001-AA   | ● 72   | 82   |     | dBc   |
|                  |                                                                              | 70MHz Input (PGA = 0) LTM9001-AD      | ● 72.6 | 83   |     | dBc   |
|                  |                                                                              | 70MHz Input (PGA = 1) LTM9001-AD      |        | 86   |     | dBc   |
|                  |                                                                              | 140MHz Input (PGA = 0) LTM9001-BA     | ● 64   | 72   |     | dBc   |
|                  |                                                                              | 140MHz Input (PGA = 1) LTM9001-BA     |        | 82   |     | dBc   |
| SFDR             | Spurious Free Dynamic Range 4th or Higher                                    | 162.5MHz Input (PGA = 0) LTM9001-AA   |        | 95   |     | dBc   |
|                  |                                                                              | 162.5MHz Input (PGA = 1) LTM9001-AA   | ● 86   | 95   |     | dBc   |
|                  |                                                                              | 70MHz Input (PGA = 0) LTM9001-AD      | ● 84.5 | 95   |     | dBc   |
|                  |                                                                              | 70MHz Input (PGA = 1) LTM9001-AD      |        | 98   |     | dBc   |
|                  |                                                                              | 140MHz Input (PGA = 0) LTM9001-BA     | ● 86   | 95   |     | dBc   |
|                  |                                                                              | 140MHz Input (PGA = 1) LTM9001-BA     |        | 104  |     | dBc   |
| S/(N+D)          | Signal-to-Noise Plus Distortion Ratio                                        | 162.5MHz Input (PGA = 0) LTM9001-AA   |        | 71.4 |     | dBFS  |
|                  |                                                                              | 162.5MHz Input (PGA = 1) LTM9001-AA   | ● 67   | 68   |     | dBFS  |
|                  |                                                                              | 70MHz Input (PGA = 0) LTM9001-AD      | ● 71.2 | 74.3 |     | dBFS  |
|                  |                                                                              | 70MHz Input (PGA = 1) LTM9001-AD      |        | 72   |     | dBFS  |
|                  |                                                                              | 140MHz Input (PGA = 0) LTM9001-BA     | ● 64   | 67.5 |     | dBFS  |
|                  |                                                                              | 140MHz Input (PGA = 1) LTM9001-BA     |        | 66.4 |     | dBFS  |
| SFDR             | Spurious Free Dynamic Range at -25dBFS, Dither "OFF"                         | 162.5MHz Input (PGA = 0) LTM9001-AA   |        | 90   |     | dBFS  |
|                  |                                                                              | 162.5MHz Input (PGA = 1) LTM9001-AA   |        | 93   |     | dBFS  |
|                  | Spurious Free Dynamic Range at -15dBFS, Dither "OFF"                         | 70MHz Input (PGA = 0) LTM9001-AD      |        | 85   |     | dBFS  |
|                  |                                                                              | 70MHz Input (PGA = 1) LTM9001-AD      |        | 87   |     | dBFS  |
|                  | Spurious Free Dynamic Range at -15dBFS, Dither "OFF"                         | 140MHz Input (PGA = 0) LTM9001-BA     |        | 91   |     | dBFS  |
|                  |                                                                              | 140MHz Input (PGA = 1) LTM9001-BA     |        | 92   |     | dBFS  |
| SFDR             | Spurious Free Dynamic Range at -25dBFS, Dither "ON"                          | 162.5MHz Input (PGA = 0) LTM9001-AA   |        | 95   |     | dBFS  |
|                  |                                                                              | 162.5MHz Input (PGA = 1) LTM9001-AA   | ● 90   | 100  |     | dBFS  |
|                  | Spurious Free Dynamic Range at -15dBFS, Dither "ON"                          | 70MHz Input (PGA = 0) LTM9001-AD      | ● 90   | 92   |     | dBFS  |
|                  |                                                                              | 70MHz Input (PGA = 1) LTM9001-AD      |        | 88   |     | dBFS  |
|                  | Spurious Free Dynamic Range at -15dBFS, Dither "ON"                          | 140MHz Input (PGA = 0) LTM9001-BA     | ● 90   | 95   |     | dBFS  |
|                  |                                                                              | 140MHz Input (PGA = 1) LTM9001-BA     |        | 96   |     | dBFS  |
| IMD <sub>3</sub> | Third Order Intermodulation Distortion; 1MHz Tone Spacing, 2 Tones at -7dBFS | $f_{IN} = 162.5\text{MHz}$ LTM9001-AA |        | -78  |     | dB    |
|                  |                                                                              | $f_{IN} = 70\text{MHz}$ LTM9001-AD    |        | -84  |     | dB    |
|                  |                                                                              | $f_{IN} = 140\text{MHz}$ LTM9001-BA   |        | -84  |     | dB    |
| IIP <sub>3</sub> | Equivalent Third Order Input Intercept Point, 2 Tone                         | $f_{IN} = 162.5\text{MHz}$ LTM9001-AA |        | 24   |     | dBm   |
|                  |                                                                              | $f_{IN} = 70\text{MHz}$ LTM9001-AD    |        | 26.5 |     | dBm   |
|                  |                                                                              | $f_{IN} = 140\text{MHz}$ LTM9001-BA   |        | 29.2 |     | dBm   |

**DIGITAL INPUTS AND OUTPUTS** The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ . (Note 4)

| SYMBOL                                               | PARAMETER                  | CONDITIONS                       | MIN   | TYP | MAX | UNITS |
|------------------------------------------------------|----------------------------|----------------------------------|-------|-----|-----|-------|
| Encode Inputs (ENC <sup>+</sup> , ENC <sup>-</sup> ) |                            |                                  |       |     |     |       |
| V <sub>ID</sub>                                      | Differential Input Voltage |                                  | ● 0.2 |     |     | V     |
| V <sub>ICM</sub>                                     | Common Mode Input Voltage  | Internally Set<br>Externally Set |       | 1.6 |     | V     |
|                                                      |                            |                                  | 1.2   |     | 3.1 | V     |
| R <sub>IN</sub>                                      | Input Resistance           |                                  |       | 100 |     | Ω     |
| C <sub>IN</sub>                                      | Input Capacitance          | (Note 7)                         |       | 3   |     | pF    |

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**DIGITAL INPUTS AND OUTPUTS**

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ . (Note 4)

| SYMBOL                                         | PARAMETER                   | CONDITIONS                                                                                    |   | MIN   | TYP           | MAX      | UNITS         |
|------------------------------------------------|-----------------------------|-----------------------------------------------------------------------------------------------|---|-------|---------------|----------|---------------|
| <b>Logic Inputs (DITH, PGA, ADCSHDN, RAND)</b> |                             |                                                                                               |   |       |               |          |               |
| $V_{IH}$                                       | High Level Input Voltage    | $V_{DD} = 3.3\text{V}$                                                                        | ● | 2     |               |          | V             |
| $V_{IL}$                                       | Low Level Input Voltage     | $V_{DD} = 3.3\text{V}$                                                                        | ● |       |               | 0.8      | V             |
| $I_{IN}$                                       | Input Current               | $V_{IN} = 0\text{V to } V_{DD}$                                                               | ● |       |               | $\pm 10$ | $\mu\text{A}$ |
| $C_{IN}$                                       | Input Capacitance           | (Note 7)                                                                                      |   |       | 1.5           |          | pF            |
| <b>Logic Inputs (AMPSHDN)</b>                  |                             |                                                                                               |   |       |               |          |               |
| $V_{IH}$                                       | High Level Input Voltage    | $V_{CC} = 3.3\text{V}$                                                                        | ● | 2     |               |          | V             |
| $V_{IL}$                                       | Low Level Input Voltage     | $V_{CC} = 3.3\text{V}$                                                                        | ● |       |               | 0.8      | V             |
| $I_{IH}$                                       | Input High Current          | $V_{IN} = 2\text{V}$                                                                          |   |       | 1.3           |          | $\mu\text{A}$ |
| $I_{IL}$                                       | Input Low Current           | $V_{IN} = 0.8\text{V}$                                                                        |   |       | 0.1           |          | $\mu\text{A}$ |
| $C_{IN}$                                       | Input Capacitance           | (Note 7)                                                                                      |   |       | 1.5           |          | pF            |
| <b>Logic Outputs (CMOS Mode)</b>               |                             |                                                                                               |   |       |               |          |               |
| <b><math>OV_{DD} = 3.3\text{V}</math></b>      |                             |                                                                                               |   |       |               |          |               |
| $V_{OH}$                                       | High Level Output Voltage   | $V_{DD} = 3.3\text{V}, I_O = -10\mu\text{A}$<br>$V_{DD} = 3.3\text{V}, I_O = -200\mu\text{A}$ | ● | 3.1   | 3.299<br>3.29 |          | V<br>V        |
| $V_{OL}$                                       | Low Level Output Voltage    | $V_{DD} = 3.3\text{V}, I_O = 10\mu\text{A}$<br>$V_{DD} = 3.3\text{V}, I_O = 1.6\text{mA}$     | ● |       | 0.01<br>0.1   | 0.4      | V<br>V        |
| $I_{SOURCE}$                                   | Output Source Current       | $V_{OUT} = 0\text{V}$                                                                         |   |       | -50           |          | mA            |
| $I_{SINK}$                                     | Output Sink Current         | $V_{OUT} = 3.3\text{V}$                                                                       |   |       | 50            |          | mA            |
| <b><math>OV_{DD} = 2.5\text{V}</math></b>      |                             |                                                                                               |   |       |               |          |               |
| $V_{OH}$                                       | High Level Output Voltage   | $V_{DD} = 3.3\text{V}, I_O = -200\mu\text{A}$                                                 |   |       | 2.49          |          | V             |
| $V_{OL}$                                       | Low Level Output Voltage    | $V_{DD} = 3.3\text{V}, I_O = 1.6\text{mA}$                                                    |   |       | 0.1           |          | V             |
| <b><math>OV_{DD} = 1.8\text{V}</math></b>      |                             |                                                                                               |   |       |               |          |               |
| $V_{OH}$                                       | High Level Output Voltage   | $V_{DD} = 3.3\text{V}, I_O = -200\mu\text{A}$                                                 |   |       | 1.79          |          | V             |
| $V_{OL}$                                       | Low Level Output Voltage    | $V_{DD} = 3.3\text{V}, I_O = 1.6\mu\text{A}$                                                  |   |       | 0.1           |          | V             |
| <b>Logic Outputs (LVDS Mode)</b>               |                             |                                                                                               |   |       |               |          |               |
| <b>Standard LVDS</b>                           |                             |                                                                                               |   |       |               |          |               |
| $V_{OD}$                                       | Differential Output Voltage | 100 $\Omega$ Differential Load                                                                | ● | 247   | 350           | 454      | mV            |
| $V_{OS}$                                       | Output Common Mode Voltage  | 100 $\Omega$ Differential Load                                                                | ● | 1.125 | 1.2           | 1.375    | V             |
| <b>Low Power LVDS</b>                          |                             |                                                                                               |   |       |               |          |               |
| $V_{OD}$                                       | Differential Output Voltage | 100 $\Omega$ Differential Load                                                                | ● | 125   | 175           | 250      | mV            |
| $V_{OS}$                                       | Output Common Mode Voltage  | 100 $\Omega$ Differential Load                                                                | ● | 1.125 | 1.2           | 1.375    | V             |

**POWER REQUIREMENTS**

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ . (Note 4)

| SYMBOL     | PARAMETER                 | CONDITIONS               |   | MIN   | TYP | MAX   | UNITS |
|------------|---------------------------|--------------------------|---|-------|-----|-------|-------|
| $V_{DD}$   | ADC Analog Supply Voltage | (Note 8)                 | ● | 3.135 | 3.3 | 3.465 | V     |
| $V_{CC}$   | Amplifier Supply Voltage  |                          |   | 2.85  |     | 3.5   | V     |
| $I_{CC}$   | Amplifier Supply Current  |                          | ● |       | 100 | 136   | mA    |
| $P_{SHDN}$ | Total Shutdown Power      | AMPSHDN = ADCSHDN = 3.3V |   |       | 10  |       | mW    |

# LTM9001-Ax/LTM9001-Bx

## POWER REQUIREMENTS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ . (Note 4)

| SYMBOL                            | PARAMETER               | CONDITIONS               |        | MIN | TYP          | MAX          | UNITS    |
|-----------------------------------|-------------------------|--------------------------|--------|-----|--------------|--------------|----------|
| <b>Standard LVDS Output Mode</b>  |                         |                          |        |     |              |              |          |
| $OV_{DD}$                         | Output Supply Voltage   | (Note 8)                 | ●      | 3   | 3.3          | 3.6          | V        |
| $I_{VDD}$                         | Analog Supply Current   | LTM9001-Ax<br>LTM9001-BA | ●<br>● |     | 400<br>465   | 500<br>550   | mA<br>mA |
| $I_{OVDD}$                        | Output Supply Current   |                          | ●      |     | 74           | 90           | mA       |
| $P_{DISS}$                        | Power Dissipation       | LTM9001-Ax<br>LTM9001-BA | ●<br>● |     | 1564<br>1779 | 1947<br>2112 | mW<br>mW |
| <b>Low Power LVDS Output Mode</b> |                         |                          |        |     |              |              |          |
| $OV_{DD}$                         | Output Supply Voltage   | (Note 8)                 | ●      | 3   | 3.3          | 3.6          | V        |
| $I_{VDD}$                         | Analog Supply Current   | LTM9001-Ax<br>LTM9001-BA | ●<br>● |     | 400<br>465   | 500<br>550   | mA<br>mA |
| $I_{OVDD}$                        | Output Supply Current   |                          | ●      |     | 41           | 50           | mA       |
| $P_{DISS}$                        | Power Dissipation       | LTM9001-Ax<br>LTM9001-BA | ●<br>● |     | 1455<br>1670 | 1815<br>1980 | mW<br>mW |
| <b>CMOS Output Mode</b>           |                         |                          |        |     |              |              |          |
| $OV_{DD}$                         | Output Supply Voltage   | (Note 8)                 | ●      | 0.5 |              | 3.6          | V        |
| $I_{VDD}$                         | Analog Supply Current   | LTM9001-Ax<br>LTM9001-BA | ●<br>● |     | 380<br>460   | 450<br>530   | mA<br>mA |
| $P_{DISS}$                        | ADC Power Dissipation   | LTM9001-Ax<br>LTM9001-BA | ●<br>● |     | 1320<br>1584 | 1650<br>1914 | mW<br>mW |
| $P_{DISS(TOTAL)}$                 | Total Power Dissipation | LTM9001-Ax<br>LTM9001-BA |        |     | 1650<br>1914 |              | mW<br>mW |

## TIMING CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ . (Note 4)

| SYMBOL                                           | PARAMETER                   | CONDITIONS                                                                                                                                                         |                  | MIN                        | TYP                              | MAX                          | UNITS                |
|--------------------------------------------------|-----------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------|----------------------------|----------------------------------|------------------------------|----------------------|
| $f_S$                                            | Sampling Frequency (Note 8) | LTM9001-Ax<br>LTM9001-BA                                                                                                                                           | ●<br>●           | 1<br>1                     |                                  | 130<br>160                   | MHz<br>MHz           |
| $t_L$                                            | ENC Low Time (Note 7)       | Duty Cycle Stabilizer Off (LTM9001-Ax)<br>Duty Cycle Stabilizer Off (LTM9001-BA)<br>Duty Cycle Stabilizer On (LTM9001-Ax)<br>Duty Cycle Stabilizer On (LTM9001-BA) | ●<br>●<br>●<br>● | 3.65<br>2.97<br>2.6<br>2.1 | 3.846<br>3.125<br>3.846<br>3.125 | 1000<br>1000<br>1000<br>1000 | ns<br>ns<br>ns<br>ns |
| $t_H$                                            | ENC High Time (Note 7)      | Duty Cycle Stabilizer Off (LTM9001-Ax)<br>Duty Cycle Stabilizer Off (LTM9001-BA)<br>Duty Cycle Stabilizer On (LTM9001-Ax)<br>Duty Cycle Stabilizer On (LTM9001-BA) | ●<br>●<br>●<br>● | 3.65<br>2.97<br>2.6<br>2.1 | 3.846<br>3.125<br>3.846<br>3.125 | 1000<br>1000<br>1000<br>1000 | ns<br>ns<br>ns<br>ns |
| <b>LVDS Output Mode (Standard and Low Power)</b> |                             |                                                                                                                                                                    |                  |                            |                                  |                              |                      |
| $t_D$                                            | ENC to DATA Delay           | (Note 7)                                                                                                                                                           | ●                | 1.3                        | 2.5                              | 4                            | ns                   |
| $t_C$                                            | ENC to CLKOUT Delay         | (Note 7)                                                                                                                                                           | ●                | 1.3                        | 2.5                              | 4                            | ns                   |
| $t_{SKEW}$                                       | DATA to CLKOUT Skew         | $(t_C - t_D)$ (Note 7)                                                                                                                                             | ●                | -0.6                       | 0                                | 0.6                          | ns                   |
| $t_{RISE}$                                       | Output Rise Time            |                                                                                                                                                                    |                  |                            | 0.5                              |                              | ns                   |
| $t_{FALL}$                                       | Output Fall Time            |                                                                                                                                                                    |                  |                            | 0.5                              |                              | ns                   |
|                                                  | Data Latency                |                                                                                                                                                                    |                  |                            | 7                                |                              | Cycles               |

## TIMING CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ . (Note 4)

| SYMBOL                  | PARAMETER           | CONDITIONS             |   | MIN  | TYP    | MAX | UNITS            |
|-------------------------|---------------------|------------------------|---|------|--------|-----|------------------|
| <b>CMOS Output Mode</b> |                     |                        |   |      |        |     |                  |
| $t_D$                   | ENC to DATA Delay   | (Note 7)               | ● | 1.3  | 2.7    | 4   | ns               |
| $t_C$                   | ENC to CLKOUT Delay | (Note 7)               | ● | 1.3  | 2.7    | 4   | ns               |
| $t_{SKEW}$              | DATA to CLKOUT Skew | $(t_C - t_D)$ (Note 7) | ● | -0.6 | 0      | 0.6 | ns               |
|                         | Data Latency        | Full Rate CMOS Demuxed |   |      | 7<br>7 |     | Cycles<br>Cycles |

**Note 1:** Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

**Note 2:** All voltage values are with respect to ground with GND and OGND wired together (unless otherwise noted).

**Note 3:** Gain is measured from  $IN^+/IN^-$  through the ADC. The amplifier gain is attenuated by the filter, (See the typical performance characteristics section for "IF Frequency Response").

**Note 4:**  $V_{CC} = V_{DD} = 3.3\text{V}$ ,  $f_{SAMPLE}$  = maximum sample frequency, LVDS outputs, differential  $ENC^+/ENC^- = 2V_{P-P}$  with 1.6V common mode, input

range = -1dBFS with  $PGA = 0$  with differential drive, AC-coupled inputs, unless otherwise noted.

**Note 5:** Integral nonlinearity is defined as the deviation of a code from a "best fit straight line" to the transfer curve. The deviation is measured from the center of the quantization band.

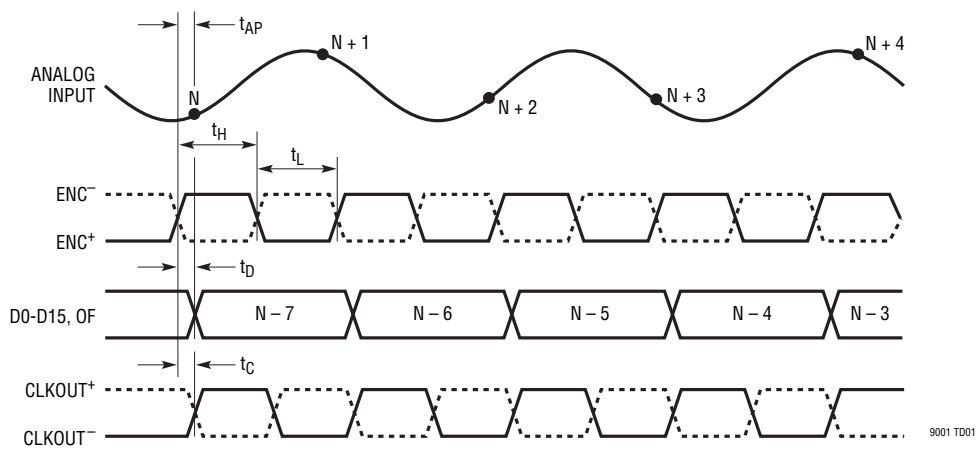
**Note 6:** Offset error is the voltage applied between the  $IN^+$  and  $IN^-$  pins required to make the output code flicker between 0000 0000 0000 0000 and 1111 1111 1111 1111.

**Note 7:** Guaranteed by design, not subject to test.

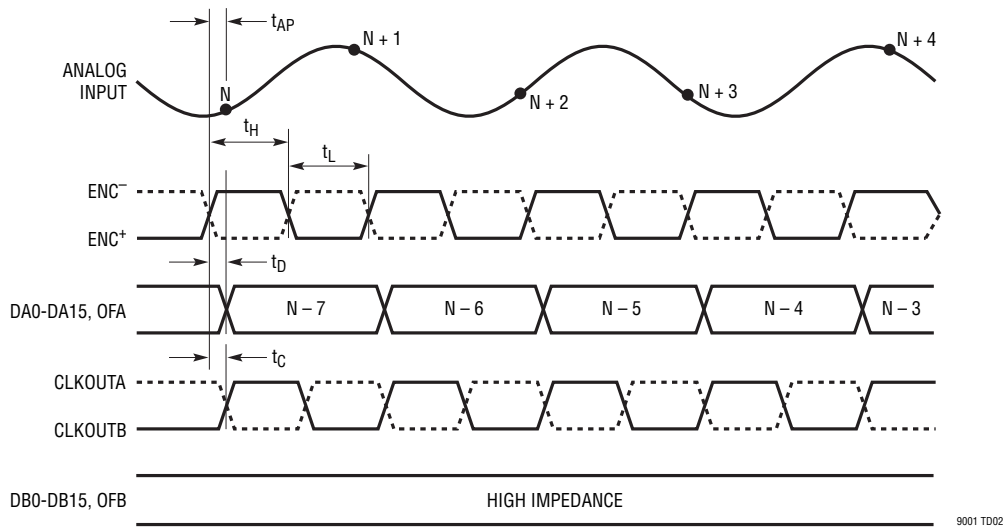
**Note 8:** Recommended operating conditions.

TIMING DIAGRAM

LVDS Output Mode Timing  
All Outputs are Differential and Have LVDS Levels



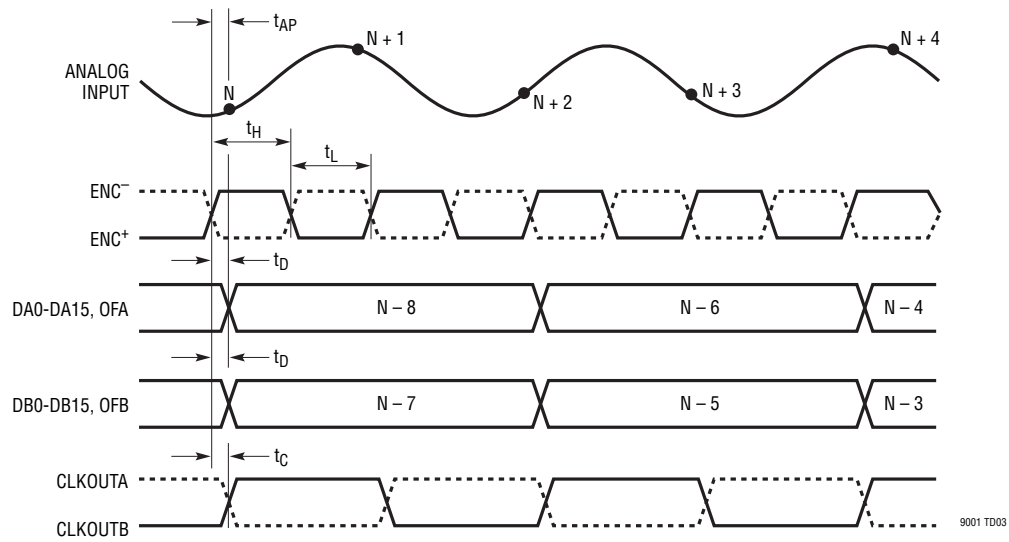
Full-Rate CMOS Output Mode Timing  
All Outputs are Single-Ended and Have CMOS Levels



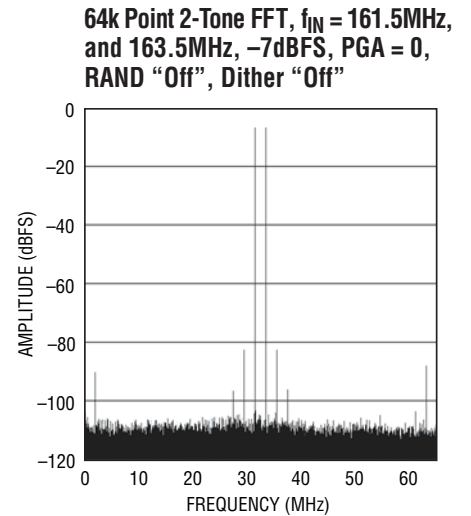
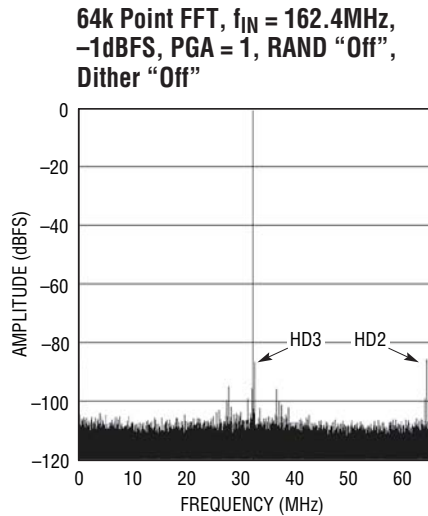
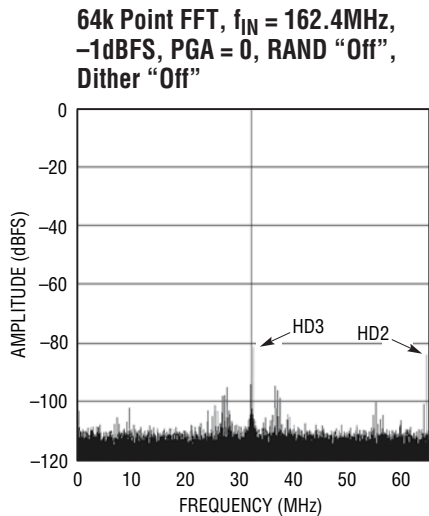
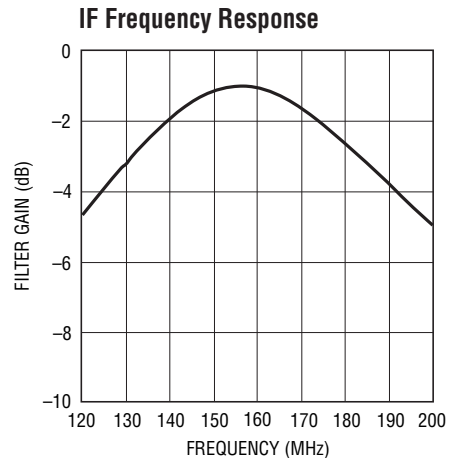
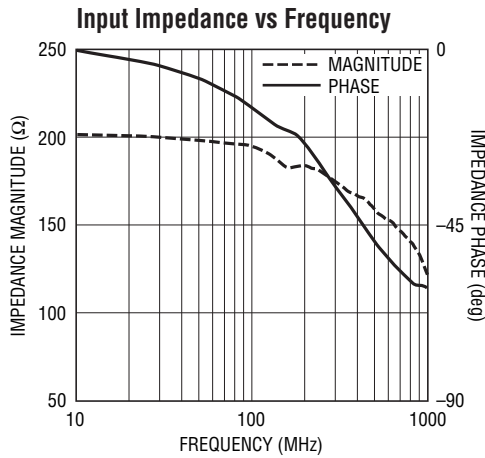
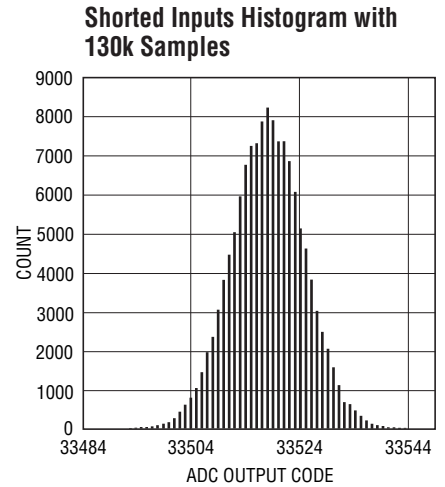
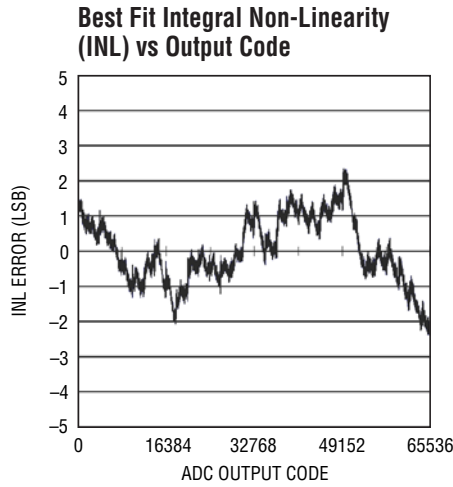
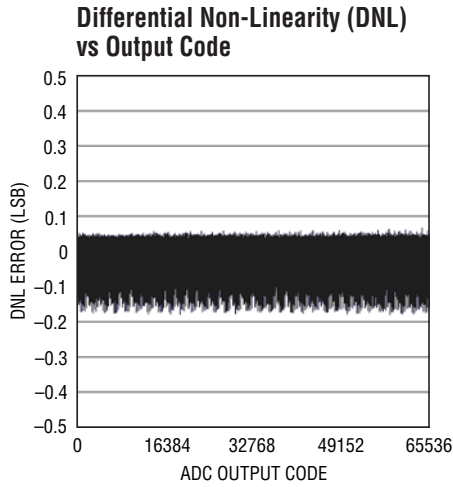


## TIMING DIAGRAM

Demultiplexed CMOS Output Mode Timing  
All Outputs are Single-Ended and Have CMOS Levels

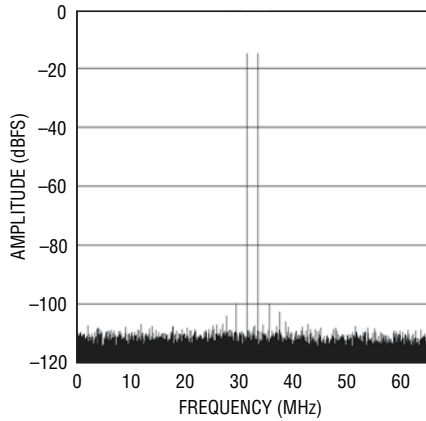


## TYPICAL PERFORMANCE CHARACTERISTICS (LTM9001-AA)



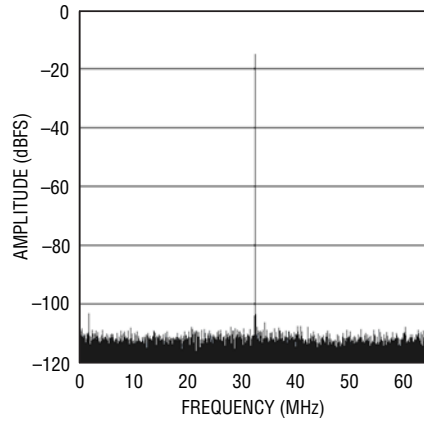
# TYPICAL PERFORMANCE CHARACTERISTICS (LTM9001-AA)

64k Point 2-Tone FFT,  $f_{IN} = 161.5\text{MHz}$ , and  $163.5\text{MHz}$ ,  $-15\text{dBFS}$ ,  $\text{PGA} = 0$ ,  $\text{RAND}$  "Off",  $\text{Dither}$  "Off"



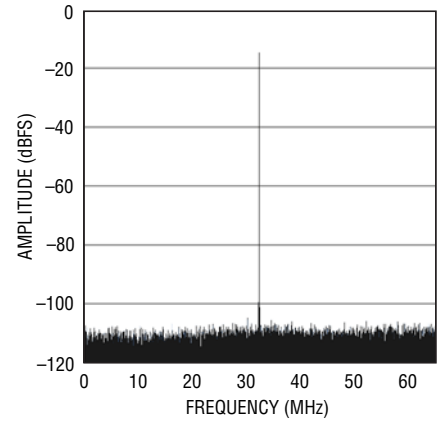
9001 G09

64k Point FFT,  $f_{IN} = 162.4\text{MHz}$ ,  $-15\text{dBFS}$ ,  $\text{PGA} = 0$ ,  $\text{RAND}$  "Off",  $\text{Dither}$  "Off"



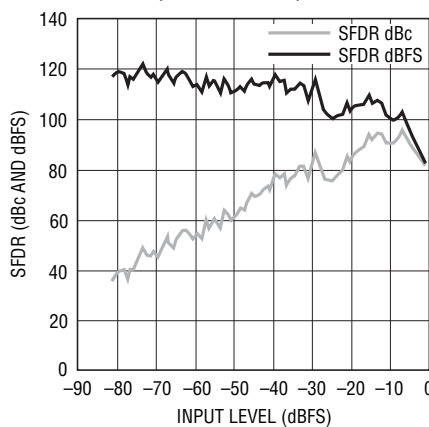
9001 G10

64k Point FFT,  $f_{IN} = 162.4\text{MHz}$ ,  $-15\text{dBFS}$ ,  $\text{PGA} = 0$ ,  $\text{RAND}$  "Off",  $\text{Dither}$  "On"



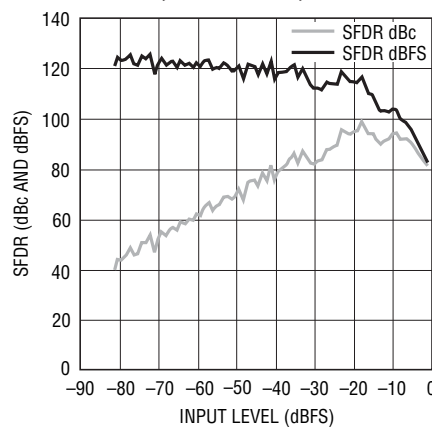
9001 G11

SFDR vs Input Level,  $f_{IN} = 162.4\text{MHz}$ ,  $\text{PGA} = 0$ ,  $\text{RAND}$  "Off",  $\text{Dither} = \text{"Off"}$



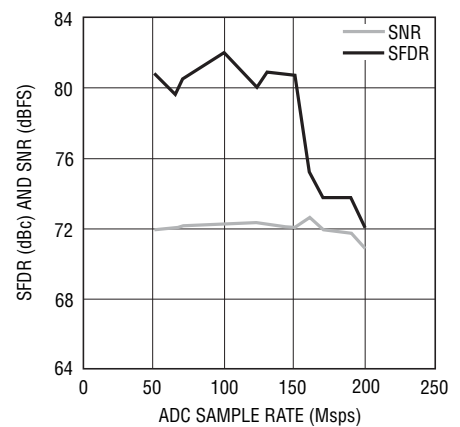
9001 G12

SFDR vs Input Level,  $f_{IN} = 162.4\text{MHz}$ ,  $\text{PGA} = 0$ ,  $\text{RAND}$  "Off",  $\text{Dither} = \text{"On"}$



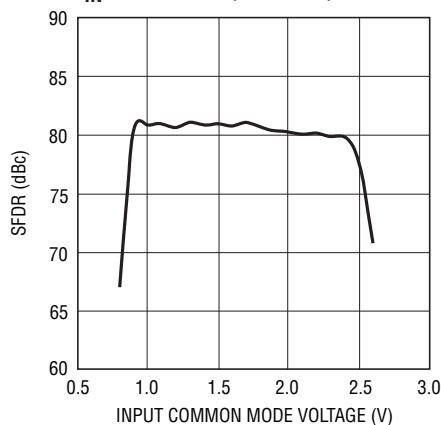
9001 G13

SFDR and SNR vs Sample Rate,  $f_{IN} = 162.4\text{MHz}$ ,  $-1\text{dBFS}$ ,  $\text{PGA} = 0$ ,  $\text{RAND}$  "Off",  $\text{Dither} = \text{"Off"}$



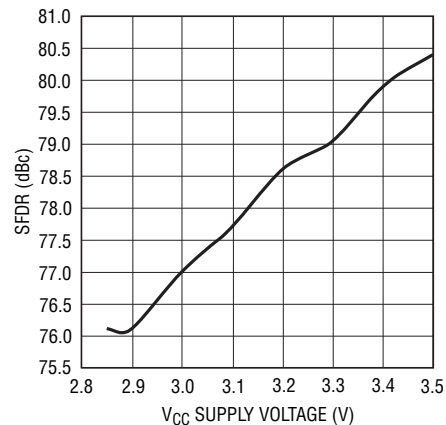
9001 G14

SFDR vs Input Common Mode Voltage,  $f_{IN} = 162.4\text{MHz}$ ,  $-1\text{dBFS}$ ,  $\text{PGA} = 0$



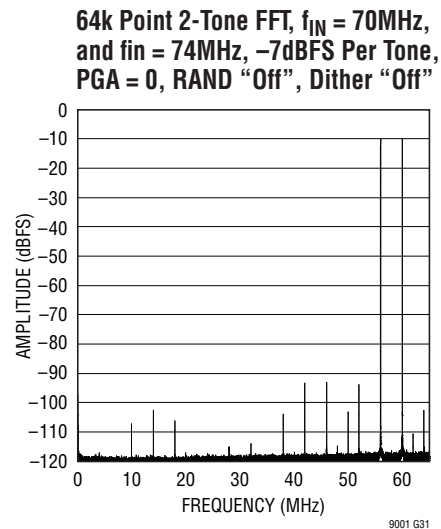
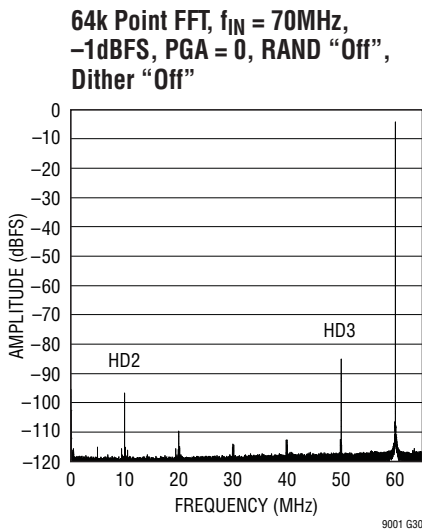
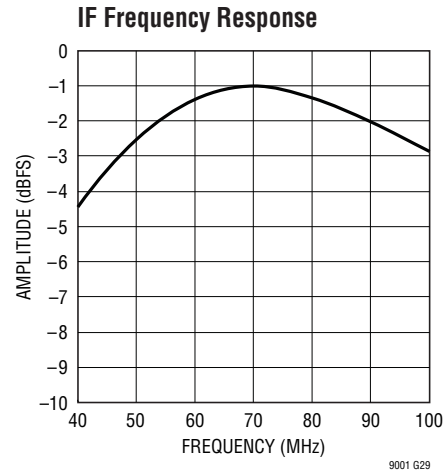
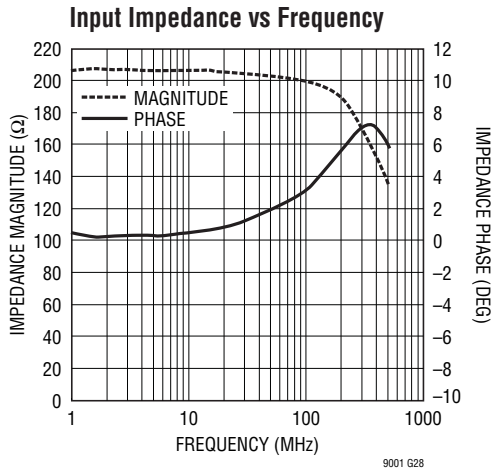
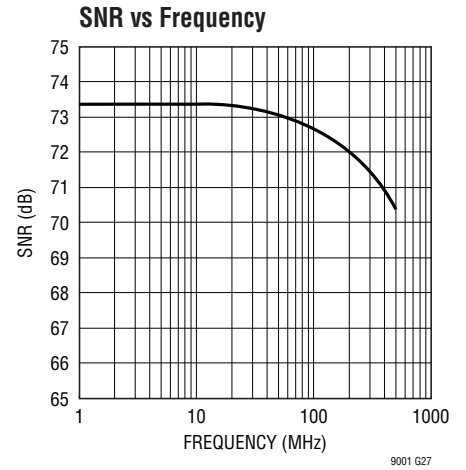
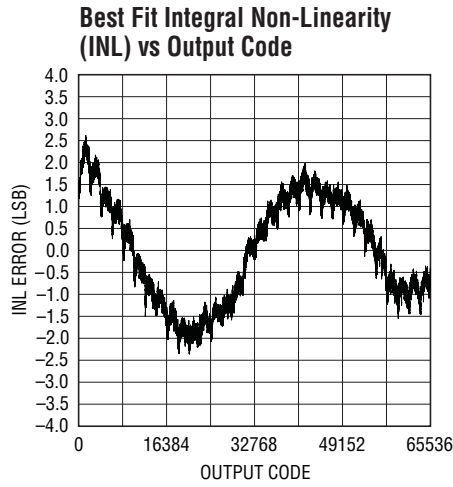
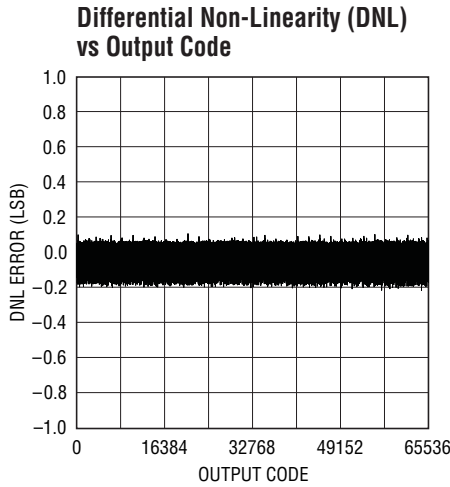
9001 G15

SFDR vs  $V_{CC}$  Supply Voltage,  $f_{IN} = 162.4\text{MHz}$ ,  $-1\text{dBFS}$ ,  $\text{PGA} = 0$



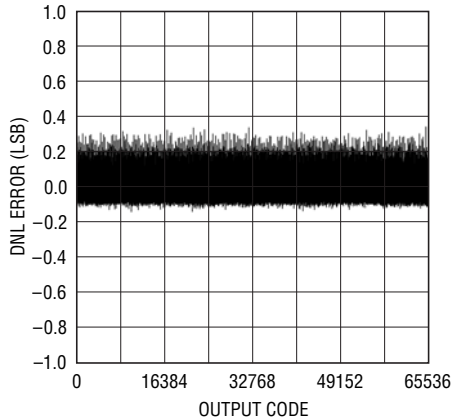
9001 G16

## TYPICAL PERFORMANCE CHARACTERISTICS (LTM9001-AD)



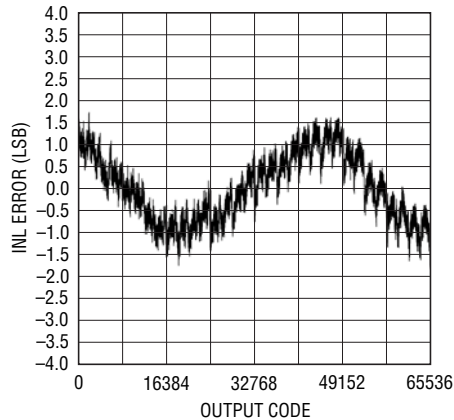
# TYPICAL PERFORMANCE CHARACTERISTICS (LTM9001-BA)

**Differential Non-Linearity (DNL)  
vs Output Code**



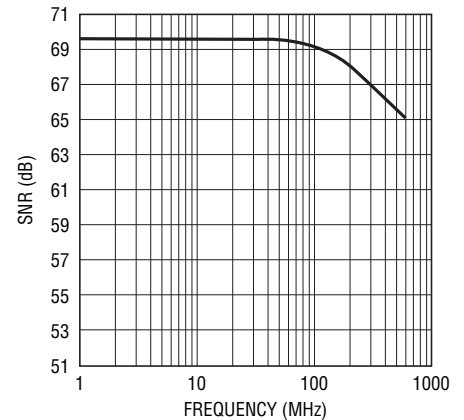
9001 G17

**Best Fit Integral Non-Linearity  
(INL) vs Output Code**



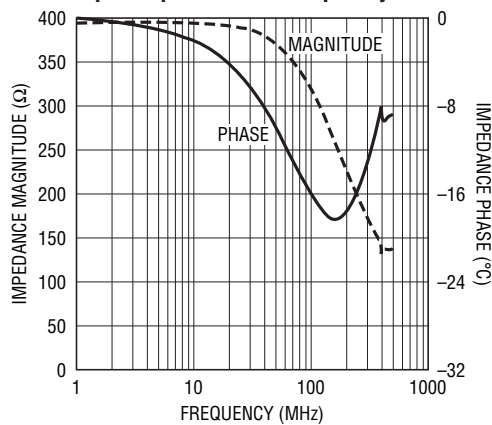
9001 G18

**SNR vs Frequency**



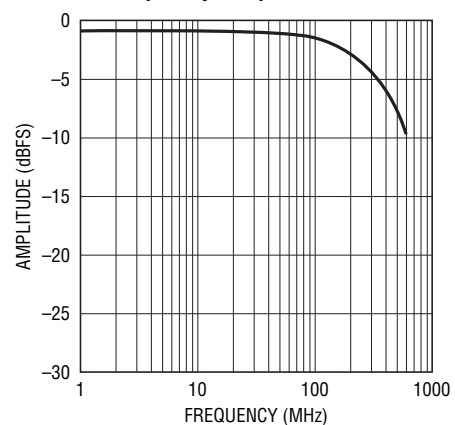
9001 G19

**Input Impedance vs Frequency**



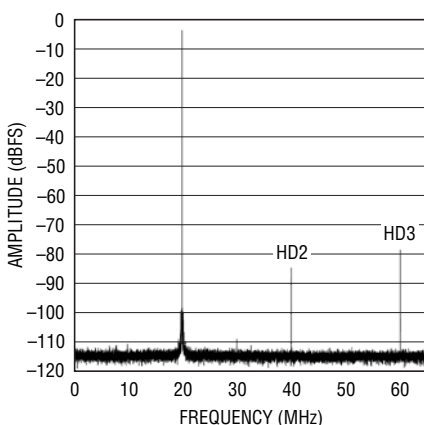
9001 G20

**IF Frequency Response**



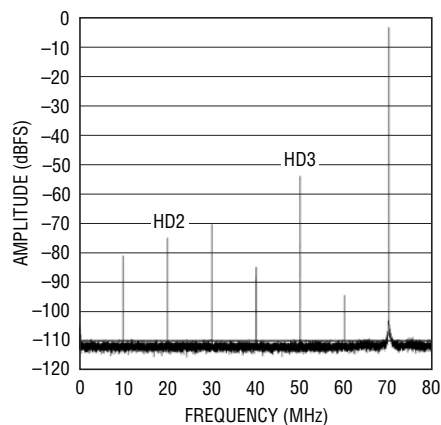
9001 G21

**64k Point FFT,  $f_{IN} = 140\text{MHz}$ ,  
-1dBFS, PGA = 0, RAND "Off",  
Dither "Off"**



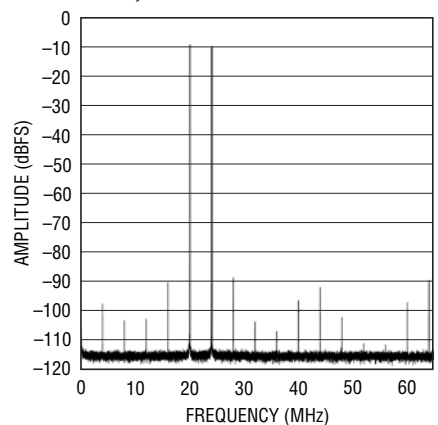
9001 G22

**64k Point FFT,  $f_{IN} = 250\text{MHz}$ ,  
-1dBFS, PGA = 0, RAND "Off",  
Dither "Off"**



9001 G23

**64k Point 2-Tone FFT,  $f_{IN} = 136\text{MHz}$ ,  
-7dBFS Per Tone, PGA = 0, RAND  
"Off", Dither "Off"**



9001 G24

9001fc

## PIN FUNCTIONS

### Supply Pins

**V<sub>CC</sub> (Pins E1, E2):** 3.3V Analog Supply Pin for Amplifier. The voltage on this pin provides power for the amplifier stage only and is internally bypassed to GND.

**V<sub>DD</sub> (Pins E5, D5):** 3.3V Analog Supply Pin for ADC. This supply is internally bypassed to GND.

**OV<sub>DD</sub> (Pins A6, G9):** Positive Supply for the ADC Output Drivers. This supply is internally bypassed to OGND.

**GND (Pins A1, A2, A4, B2, B4, C2, C4, D1, D2, D4, E4, F1, F2, F4, G2, G4, H2, H4, J1, J2, J4):** Analog Ground.

**OGND (Pins A5, A9, G8, J9):** ADC Output Driver Ground.

### Analog Inputs

**IN<sup>+</sup> (Pin G1):** Positive (Non-Inverting) Amplifier Input.

**IN<sup>-</sup> (Pin H1):** Negative (Inverting) Amplifier Input.

**DNC (Pins C3, D3):** Do Not Connect. These pins are used for testing and should not be connected on the PCB. They may be soldered to unconnected pads and should be well isolated. The DNC pins connect to the signal path prior to the ADC inputs; therefore, care should be taken to keep other signals away from these sensitive nodes.

**ENC<sup>+</sup> (Pin C1):** Positive Differential Encode Input. The sampled analog input is held on the rising edge of ENC<sup>+</sup>. This input is internally biased to 1.6V through a 6.2k resistor. Output data can be latched on the rising edge of ENC<sup>+</sup>. The Encode pins have a differential 100Ω input impedance.

**ENC<sup>-</sup> (Pin B1):** Negative Differential Encode Input. The sampled analog input is held on the falling edge of ENC<sup>-</sup>. This input is internally biased to 1.6V through a 6.2k resistor. Bypass to ground with a 0.1μF capacitor for a single-ended encode signal. The encode pins have a differential 100Ω input impedance.

### Control Inputs

**SENSE (Pin J3):** Reference Mode Select and External Reference Input. Tie SENSE to V<sub>DD</sub> to select the internal 2.5V bandgap reference. An external reference of 2.5V or 1.25V may be used; both reference values will set the maximum full-scale input range.

**AMPSHDN (Pin H3):** Power Shutdown Pin for Amplifier. This pin is a logic input referenced to analog ground. AMPSHDN = low results in normal operation. AMPSHDN = high results in powered down amplifier with typically 3mA amplifier supply current.

**MODE (Pin G3):** Output Format and Clock Duty Cycle Stabilizer Selection Pin. Connecting MODE to 0V selects offset binary output format and disables the clock duty cycle stabilizer. Connecting MODE to 1/3V<sub>DD</sub> selects offset binary output format and enables the clock duty cycle stabilizer. Connecting MODE to 2/3V<sub>DD</sub> selects 2's complement output format and enables the clock duty cycle stabilizer. Connecting MODE to V<sub>DD</sub> selects 2's complement output format and disables the clock duty cycle stabilizer.

**RAND (Pin F3):** Digital Output Randomization Selection Pin. RAND = low results in normal operation. RAND = high selects D1 to D15 to be EXCLUSIVE-ORed with D0 (the LSB). The output can be decoded by again applying an XOR operation between the LSB and all other bits. This mode of operation reduces the effects of digital output interference.

**PGA (Pin E3):** Programmable Gain Amplifier Control Pin. PGA = low selects the normal (maximum) input voltage range. PGA = high selects a 3.5dB reduced input range for slightly better distortion performance at the expense of SNR.

**ADCSHDN (Pin B3):** Power Shutdown Pin for ADC. ADCSHDN = low results in normal operation. ADCSHDN = high results in powered down analog circuitry and the digital outputs are placed in a high impedance state.

**DITH (Pin A3):** Internal Dither Enable Pin. DITH = low disables internal dither. DITH = high enables internal dither. Refer to Internal Dither section of this data sheet for details on dither operation.

**LVDS (Pin F5):** Data Output Mode Select Pin. Connecting LVDS to 0V selects full rate CMOS mode. Connecting LVDS to 1/3V<sub>DD</sub> selects demultiplexed CMOS mode. Connecting LVDS to 2/3V<sub>DD</sub> selects low power LVDS mode. Connecting LVDS to V<sub>DD</sub> selects standard LVDS mode.

## PIN FUNCTIONS

### Digital Outputs

#### For CMOS Mode, Full Rate or Demultiplexed

**DA0 to DA15 (Pins E9 to H5):** Digital Outputs, A Bus. DA15 is the MSB. Output bus for full rate CMOS mode and demultiplexed mode.

**CLKOUTA (Pin E8):** Inverted Data Valid Output. CLKOUTA will toggle at the sample rate in full rate CMOS mode or at 1/2 the sample rate in demultiplexed mode. Latch the data on the rising edge of CLKOUTA.

**OFA (Pin G5):** Overflow/Underflow Digital Output for the A Bus. OFA is high when an overflow or underflow has occurred on the A bus.

**DB0 to DB15 (Pins B5 to D9):** Digital Outputs, B Bus. DB15 is the MSB. Active in demultiplexed mode. The B bus is in a high impedance state in full rate CMOS mode.

**CLKOUTB (Pin E7):** Data Valid Output. CLKOUTB will toggle at the sample rate in full rate CMOS mode or at 1/2 the sample rate in demultiplexed mode. Latch the data on the falling edge of CLKOUTB.

**OFA (Pin G5):** Overflow/Underflow Digital Output for the A Bus. OFA is high when an overflow or underflow has occurred on the A bus.

#### For LVDS Mode, Standard or Low Power

**D0<sup>-</sup>/D0<sup>+</sup> to D15<sup>-</sup>/D15<sup>+</sup> (Pins B5 to G6):** LVDS Digital Outputs. All LVDS outputs require differential 100Ω termination resistors at the LVDS receiver. D15<sup>+</sup>/D15<sup>-</sup> is the MSB.

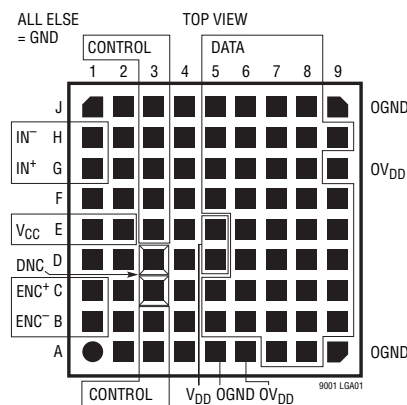
**CLKOUT<sup>-</sup>/CLKOUT<sup>+</sup> (Pins E6, E7):** LVDS Data Valid Output. Latch data on the rising edge of CLKOUT<sup>+</sup>, falling edge of CLKOUT<sup>-</sup>.

**OF<sup>-</sup>/OF<sup>+</sup> (Pins H5, G5):** Overflow/Underflow Digital Output. OF is high when an over or under flow has occurred.

#### Pin Configuration (LVDS Outputs/CMOS Outputs)

|   | 1                | 2               | 3       | 4   | 5                      | 6                        | 7                            | 8                        | 9                     |
|---|------------------|-----------------|---------|-----|------------------------|--------------------------|------------------------------|--------------------------|-----------------------|
| J | GND              | GND             | SENSE   | GND | D14 <sup>+</sup> /DA12 | D14 <sup>-</sup> /DA11   | D12 <sup>+</sup> /DA8        | D12 <sup>-</sup> /DA7    | OGND                  |
| H | IN <sup>-</sup>  | GND             | AMPSHDN | GND | OF <sup>-</sup> /DA15  | D15 <sup>-</sup> /DA13   | D13 <sup>-</sup> /DA9        | D11 <sup>-</sup> /DA5    | D11 <sup>+</sup> /DA6 |
| G | IN <sup>+</sup>  | GND             | MODE    | GND | OF <sup>+</sup> /OFA   | D15 <sup>+</sup> /DA14   | D13 <sup>+</sup> /DA10       | OGND                     | OV <sub>DD</sub>      |
| F | GND              | GND             | RAND    | GND | LVDS                   | D9 <sup>-</sup> /DA1     | D9 <sup>+</sup> /DA2         | D10 <sup>-</sup> /DA3    | D10 <sup>+</sup> /DA4 |
| E | V <sub>CC</sub>  | V <sub>CC</sub> | PGA     | GND | V <sub>DD</sub>        | CLKOUT <sup>-</sup> /OFB | CLKOUT <sup>+</sup> /CLKOUTB | D8 <sup>-</sup> /CLKOUTA | D8 <sup>+</sup> /DA0  |
| D | GND              | GND             | DNC     | GND | V <sub>DD</sub>        | D6 <sup>-</sup> /DB12    | D6 <sup>+</sup> /DB13        | D7 <sup>-</sup> /DB14    | D7 <sup>+</sup> /DB15 |
| C | ENC <sup>+</sup> | GND             | DNC     | GND | D0 <sup>+</sup> /DB1   | D4 <sup>-</sup> /DB8     | D4 <sup>+</sup> /DB9         | D5 <sup>-</sup> /DB10    | D5 <sup>+</sup> /DB11 |
| B | ENC <sup>-</sup> | GND             | ADCSHDN | GND | D0 <sup>-</sup> /DB0   | D1 <sup>-</sup> /DB2     | D1 <sup>+</sup> /DB3         | D3 <sup>+</sup> /DB7     | D3 <sup>-</sup> /DB6  |
| A | GND              | GND             | DITH    | GND | OGND                   | OV <sub>DD</sub>         | D2 <sup>-</sup> /DB4         | D2 <sup>+</sup> /DB5     | OGND                  |

#### Top View of LGA Pinout (Looking Through Component)



9001fc





## OPERATION

### DYNAMIC PERFORMANCE DEFINITIONS

#### Signal-to-Noise Plus Distortion Ratio

The signal-to-noise plus distortion ratio  $[S/(N+D)]$  is the ratio between the RMS amplitude of the fundamental input frequency and the RMS amplitude of all other frequency components at the ADC output.

#### Signal-to-Noise Ratio

The signal-to-noise (SNR) is the ratio between the RMS amplitude of the fundamental input frequency and the RMS amplitude of all other frequency components, except the first five harmonics.

#### Total Harmonic Distortion

Total harmonic distortion is the ratio of the RMS sum of all harmonics of the input signal to the fundamental itself. The out-of-band harmonics alias into the frequency band between DC and half the sampling frequency. THD is expressed as:

$$THD = -20 \log \left( \sqrt{(V_2^2 + V_3^2 + V_4^2 + \dots V_n^2)} / V_1 \right)$$

where  $V_1$  is the RMS amplitude of the fundamental frequency and  $V_2$  through  $V_n$  are the amplitudes of the second through  $n$ th harmonics.

#### Intermodulation Distortion

If the input signal consists of more than one spectral component, the transfer function nonlinearity can produce intermodulation distortion (IMD) in addition to THD. IMD is the change in one sinusoidal input caused by the presence of another sinusoidal input at a different frequency.

If two pure sine waves of frequencies  $f_a$  and  $f_b$  are applied to the input, nonlinearities in the transfer function can create

distortion products at the sum and difference frequencies of  $m f_a \pm n f_b$ , where  $m$  and  $n = 0, 1, 2, 3$ , etc.

For example, the 3rd order IMD terms include  $(2f_a + f_b)$ ,  $(f_a + 2f_b)$ ,  $(2f_a - f_b)$  and  $(f_a - 2f_b)$ . The 3rd order IMD is defined as the ratio of the RMS value of either input tone to the RMS value of the largest 3rd order IMD product.

#### Spurious Free Dynamic Range (SFDR)

The ratio of the RMS input signal amplitude to the RMS value of the peak spurious spectral component expressed in dBc. SFDR may also be calculated relative to full-scale and expressed in dBFS.

#### Aperture Delay Time

Aperture delay is the time from when a rising  $ENC^+$  equals the  $ENC^-$  voltage to the instant that the input signal is held by the sample and-hold circuit.

#### Aperture Delay Jitter

The variation in the aperture delay time from conversion to conversion. This random variation will result in noise when sampling an AC input. The signal to noise ratio due to the jitter alone will be:

$$SNR_{JITTER} = -20 \log (2\pi \cdot f_{IN} \cdot t_{JITTER})$$

### DESCRIPTION

The LTM9001 is an integrated system in a package (SiP)  $\mu$ Module<sup>®</sup> receiver that includes a high-speed, sampling 16-bit A/D converter, matching network, anti-aliasing filter and a low noise, differential amplifier with fixed gain. It is designed for digitizing high frequency, wide dynamic range signals with an intermediate frequency (IF) range up to 300MHz.

OPERATION

The following sections describe in further detail the functional operation of the LTM9001. The SiP technology allows the LTM9001 to be customized and this is described in the first section. The remaining outline follows the basic functional elements as shown in Figure 1.

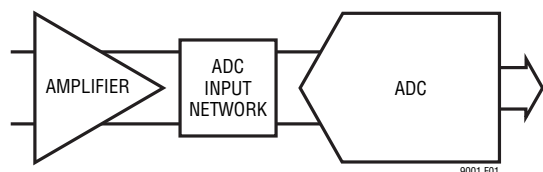


Figure 1. Basic Functional Elements

SEMI-CUSTOM OPTIONS

The  $\mu$ Module construction affords a new level of flexibility in application-specific standard products. Standard ADC and amplifier components can be integrated regardless of their process technology and matched with passive components to a particular application. The LTM9001-AA, as the first example, is configured with a 16-bit ADC sampling at rates up to 130Msps. The amplifier gain is 20dB with an input impedance of 200 $\Omega$  and an input range of 233mV<sub>P-P</sub>. The matching network is designed to optimize the interface between the amplifier output and the ADC under these conditions. Additionally, there is a 2-pole bandpass filter designed for 162.5MHz  $\pm$ 25MHz.

However, other options are possible through Linear Technology's semi-custom development program. Linear

Technology has in place a program to deliver other speed, resolution, IF range, gain and filter configurations for a wide range of applications. See Table 1 for the LTM9001-AA configuration and potential options. These semi-custom designs are based on existing ADCs and amplifiers with an appropriately modified matching network. The final subsystem is then tested to the exact parameters defined for the application. The final result is a fully integrated, accurately tested and reliable solution. For more details on the semi-custom receiver subsystem program, contact Linear Technology.

Note that not all combinations of options in Table 1 are possible at this time and specified performance may differ significantly from existing values. This data sheet discusses devices with LVDS and CMOS outputs. The lower speed options that only support CMOS outputs are available on a separate data sheet. The CMOS-only options have a different pin assignment.

AMPLIFIER INFORMATION

The amplifiers used in the LTM9001 are low noise and low distortion fully differential ADC drivers. The amplifiers are very flexible in terms of I/O coupling. They can be AC- or DC-coupled at the inputs. Users are advised to keep the input common mode voltage between 1V and 1.6V for proper operation. If the inputs are AC-coupled, the input common mode voltage is automatically biased. The input signal can be either single-ended or differential with almost no difference in distortion performance.

Table 1. Semi-Custom Options

| AMPLIFIER IF RANGE | AMPLIFIER INPUT IMPEDANCE | AMPLIFIER GAIN | FILTER                 | ADC SAMPLE RATE | ADC RESOLUTION | OUTPUT    | PART NUMBER |
|--------------------|---------------------------|----------------|------------------------|-----------------|----------------|-----------|-------------|
| 300MHz             | 200 $\Omega$              | 20dB           | 162.5MHz BPF, 50MHz BW | 130Msps         | 16-bit         | LVDS/CMOS | LTM9001-AA  |
| 300MHz             | 200 $\Omega$              | 14dB           | 70MHz BPF, 25MHz BW    | 130Msps         | 16-bit         | LVDS/CMOS | LTM9001-AD  |
| 300MHz             | 400 $\Omega$              | 8dB            | DC-300MHz LPF          | 160Msps         | 16-bit         | LVDS/CMOS | LTM9001-BA  |

Select Combination of Options from Columns Below

|           |              |      |         |         |        |           |  |
|-----------|--------------|------|---------|---------|--------|-----------|--|
| DC-300MHz | 50 $\Omega$  | 26dB | LPF TBD | 160Msps | 16-bit | LVDS/CMOS |  |
| DC-140MHz | 200 $\Omega$ | 20dB | BPF TBD | 130Msps | 14-bit | LVDS/CMOS |  |
| DC-70MHz  | 200 $\Omega$ | 14dB |         | 105Msps |        | CMOS      |  |
| DC-35MHz  | 400 $\Omega$ | 8dB  |         | 80Msps  |        | CMOS      |  |
|           | 200 $\Omega$ | 6dB  |         | 65Msps  |        | CMOS      |  |
|           |              |      |         | 40Msps  |        | CMOS      |  |
|           |              |      |         | 25Msps  |        | CMOS      |  |
|           |              |      |         | 10Msps  |        | CMOS      |  |

9001fc

## OPERATION

### ADC INPUT NETWORK

The passive network between the amplifier output stage and the ADC input stage can be configured for bandpass or lowpass response with different cutoff frequencies and bandwidths. The LTM9001-AA, for example, implements a 2-pole bandpass filter centered at 162.5MHz with 50MHz bandwidth. Note that the filter attenuates the signal at 162.5MHz by 1dB, making the overall gain of the subsystem 19dB.

For production test purposes the filter is designed to allow DC inputs into the ADC.

### CONVERTER INFORMATION

The analog-to-digital converter (ADC) is a CMOS pipelined multistep converter with a front-end PGA. As shown in the Functional Block Diagram, the converter has five pipelined ADC stages; a sampled analog input will result in a digitized value seven cycles later (see the Timing Diagram section). The encode input is differential for improved common mode noise immunity.

## APPLICATIONS INFORMATION

### INPUT SPAN

The LTM9001 is configured with a fixed input span and input impedance. With the amplifier gain and the ADC input network described above for LTM9001-AA, the full-scale input range of the driver circuit is 233mV<sub>P-P</sub>. The recommended ADC input span is achieved by tying the SENSE pin to V<sub>DD</sub>. However, the ADC input span can be changed by applying a DC voltage to the SENSE pin.

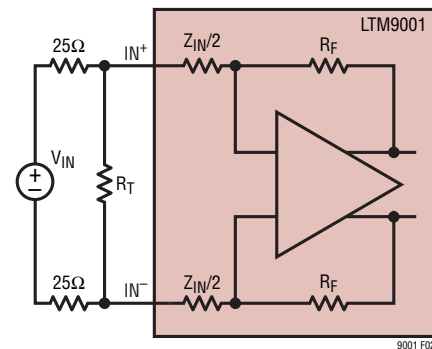
### Input Impedance and Matching

The differential input impedance of the LTM9001 can be 50Ω, 200Ω or 400Ω. In some applications the differential inputs may need to be terminated to a lower value impedance, e.g. 50Ω, in order to provide an impedance match for the source. Several choices are available.

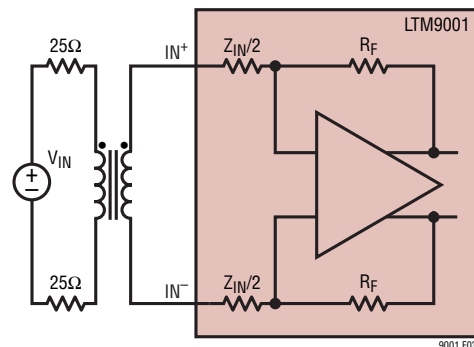
One approach is to use a differential shunt resistor (Figure 2). Another approach is to employ a wide band transformer (Figure 3). Both methods provide a wide band match. The termination resistor or the transformer must be placed close to the input pins in order to minimize the reflection due to input mismatch.

**Table 2. Differential Amplifier Input Termination Values**

| $Z_{IN}$ | $R_T$ FIG 2 |
|----------|-------------|
| 400Ω     | 57Ω         |
| 200Ω     | 66.5Ω       |
| 50Ω      | None        |



**Figure 2. Input Termination for Differential 50Ω Input Impedance Using Shunt Resistor (See Table 2 for  $R_T$  Values)**



**Figure 3. Input Termination for Differential 50Ω Input Impedance Using a Wideband Transformer**

## APPLICATIONS INFORMATION

Alternatively, one could apply a narrowband impedance match at the inputs for frequency selection and/or noise reduction.

Referring to Figure 4, amplifier inputs can be easily configured for single-ended input without a balun. The signal is fed to one of the inputs through a matching network while the other input is connected to the same impedance. In general, the single-ended input impedance and termination resistor  $R_T$  are determined by the combination of  $R_S$ ,  $Z_{IN}/2$  and  $R_F$ .

**Table 3. Single-Ended Amplifier Input Termination Values**

| $Z_{IN}$ | $R_T$ FIG 4 |
|----------|-------------|
| 400Ω     | 59Ω         |
| 200Ω     | 68.5Ω       |
| 50Ω      | 150Ω        |

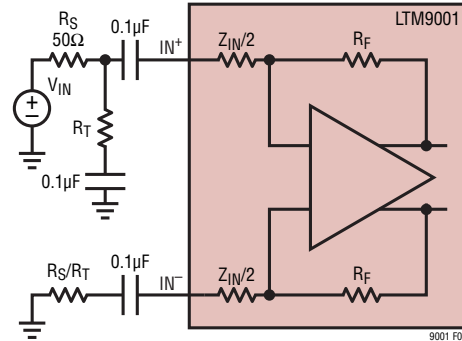
The LTM9001 amplifier is stable with all source impedances. The overall differential gain is affected by the source impedance in Figure 5:

$$A_V = |V_{OUT}/V_{IN}| = (1000/(R_S + Z_{IN}/2))$$

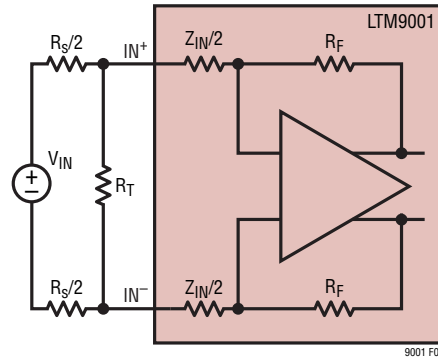
The noise performance of the amplifier also depends upon the source impedance and termination. For example, an input 1:4 transformer in Figure 3 improves the input noise figure by adding 6dB voltage gain at the inputs.

### Reference and SENSE Pin Operation

Figure 6 shows the converter reference circuitry consisting of a 2.5V bandgap reference, a programmable gain amplifier and control circuit. There are three modes of reference operation: internal reference, 1.25V external reference or 2.5V external reference. To use the internal reference,

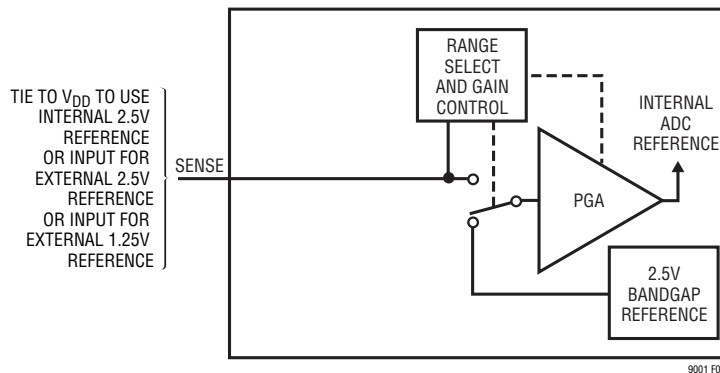


**Figure 4. Input Termination for Differential 50Ω Input Impedance Using Shunt Resistor**



**Figure 5. Calculate Differential Gain**

tie the SENSE pin to  $V_{DD}$ . To use an external reference, simply apply either a 1.25V or 2.5V reference voltage to the SENSE input pin. Both 1.25V and 2.5V applied to SENSE will result in the maximum full-scale range.



**Figure 6. Reference Circuit**

## APPLICATIONS INFORMATION

### PGA Pin

The PGA pin selects between two gain settings for the ADC front-end. PGA = low selects the maximum input span; PGA = high selects a 3.5dB lower input span. The high input range has the best SNR. For applications with high linearity requirements, the low input range will have improved distortion; however, the SNR will be 1.8dB worse. See the Typical Performance Characteristics section.

### Driving the Encode Inputs

The noise performance of the converter can depend on the encode signal quality as much as the analog input. The encode inputs are intended to be driven differentially, primarily for noise immunity from common mode noise sources. Each input is biased through a 6k resistor to a 1.6V bias. The bias resistors set the DC operating point for transformer coupled drive circuits and can set the logic threshold for single-ended drive circuits.

Any noise present on the encode signal will result in additional aperture jitter that will be RMS summed with the inherent ADC aperture jitter. In applications where jitter is critical (high input frequencies), take the following into consideration:

1. Differential drive should be used.
2. Use the largest amplitude possible. If using transformer coupling, use a higher turns ratio to increase the amplitude.

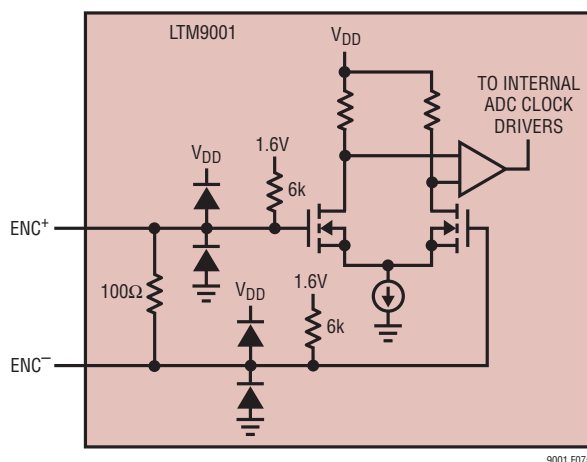


Figure 7a. Equivalent Encode Input Circuit

3. If the ADC is clocked with a fixed frequency sinusoidal signal, filter the encode signal to reduce wideband noise.
4. Balance the capacitance and series resistance at both encode inputs such that any coupled noise will appear at both inputs as common mode noise.

The encode inputs have a common mode range of 1.2V to  $V_{DD}$ . Each input may be driven from ground to  $V_{DD}$  for single-ended drive.

The encode clock inputs have a differential  $100\Omega$  input impedance. For  $50\Omega$  inputs e.g. signal generators, an additional  $100\Omega$  impedance will provide an impedance match, as shown in Figure 7b.

### Maximum and Minimum Encode Rates

The maximum encode rate for the LTM9001-Ax is 130MSPS and 160MSPS for LTM9001-BA. For the ADC to operate properly the encode signal should have a 50% ( $\pm 5\%$ ) duty cycle. Each half cycle must have at least 3.65ns (LTM9001-Ax, or 2.97ns for LTM9001-BA) for the ADC internal circuitry to have enough settling time for proper operation. Achieving a precise 50% duty cycle is easy with differential sinusoidal drive using a transformer or using symmetric differential logic such as PECL or LVDS. When using a single-ended encode signal asymmetric rise and fall times can result in duty cycles that are far from 50%.

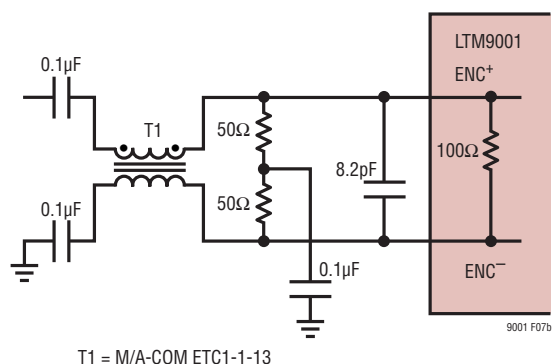


Figure 7b. Transformer Driven Encode

APPLICATIONS INFORMATION

An optional clock duty cycle stabilizer can be used if the input clock does not have a 50% duty cycle. This circuit uses the rising edge of ENC to sample the analog input. The falling edge of ENC is ignored and an internal falling edge is generated by a phase-locked loop. The input clock duty cycle can vary from 30% to 70% and the clock duty cycle stabilizer will maintain a constant 50% internal duty cycle. If the clock is turned off for a long period of time, the duty cycle stabilizer circuit will require one hundred clock cycles for the PLL to lock onto the input clock. To use the clock duty cycle stabilizer, the MODE pin must be connected to  $1/3V_{DD}$  or  $2/3V_{DD}$  using external resistors.

The lower limit of the sample rate is determined by the droop of the sample and hold circuits. The pipelined architecture of this ADC relies on storing analog signals on small valued capacitors. Junction leakage will discharge the capacitors. The specified minimum operating frequency for the LTM9001 is 1Msps.

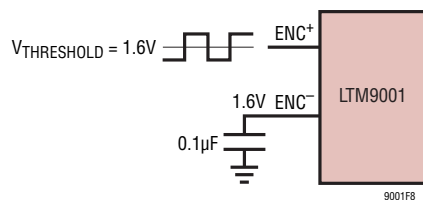


Figure 8. Single-Ended ENC Drive, Not Recommended for Low Jitter

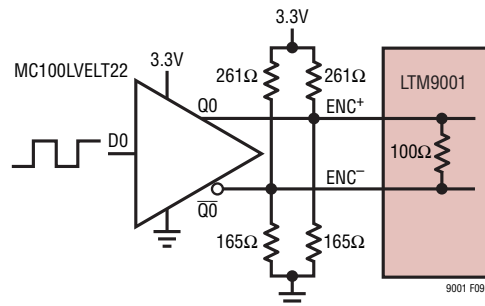


Figure 9. ENC Drive Using a CMOS to PECL Translator

DIGITAL OUTPUTS

Digital Output Modes

The LTM9001 can operate in four digital output modes: standard LVDS, low power LVDS, full rate CMOS, and demultiplexed CMOS. The LVDS pin selects the mode of operation. This pin has a four level logic input, centered at 0,  $1/3V_{DD}$ ,  $2/3V_{DD}$  and  $V_{DD}$ . An external resistive divider can be used to set the  $1/3V_{DD}$  and  $2/3V_{DD}$  logic levels. Table 4 shows the logic states for the LVDS pin.

Table 4. LVDS Pin Function

| LVDS        | DIGITAL OUTPUT MODE |
|-------------|---------------------|
| 0V(GND)     | Full-Rate CMOS      |
| $1/3V_{DD}$ | Demultiplexed CMOS  |
| $2/3V_{DD}$ | Low Power LVDS      |
| $V_{DD}$    | LVDS                |

Digital Output Buffers (CMOS Modes)

Figure 10 shows an equivalent circuit for a single output buffer in CMOS mode, full-rate or demultiplexed. Each buffer is powered by  $0V_{DD}$  and  $0GND$ , isolated from the ADC power and ground. The additional N-channel transistor in the output driver allows operation down to low voltages. The internal resistor in series with the output makes the output appear as  $50\Omega$  to external circuitry and eliminates the need for external damping resistors.

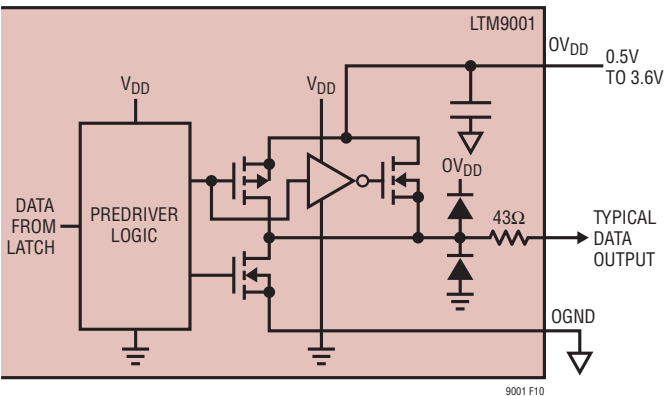


Figure 10. Equivalent Circuit for a Digital Output Buffer



## APPLICATIONS INFORMATION

As with all high speed/high resolution converters, the digital output loading can affect the performance. The digital outputs of the LTM9001 should drive a minimum capacitive load to avoid possible interaction between the digital outputs and sensitive input circuitry. The output should be buffered with a device such as an ALVCH16373 CMOS latch. For full speed operation the capacitive load should be kept under 10pF. A resistor in series with the output may be used but is not required since the ADC has a series resistor of 43Ω on chip.

Lower  $OV_{DD}$  voltages will also help reduce interference from the digital outputs.

### Digital Output Buffers (LVDS Modes)

Figure 11 shows an equivalent circuit for an LVDS output pair. A 3.5mA current is steered from  $OUT^+$  to  $OUT^-$  or vice versa, which creates a  $\pm 350mV$  differential voltage across the 100Ω termination resistor at the LVDS receiver.

A feedback loop regulates the common mode output voltage to 1.2V. For proper operation each LVDS output pair must be terminated with an external 100Ω termination resistor, even if the signal is not used (such as  $OF^+/OF^-$  or  $CLKOUT^+/CLKOUT^-$ ). To minimize noise the PC board traces for each LVDS output pair should be routed close together. To minimize clock skew all LVDS PC board traces should have about the same length.

In low power LVDS mode 1.75mA is steered between the differential outputs, resulting in  $\pm 175mV$  at the LVDS receiver's 100Ω termination resistor. The output common mode voltage is 1.2V, the same as standard LVDS mode.

### Data Format

The LTM9001 parallel digital output can be selected for offset binary or 2's complement format. The format is selected with the MODE pin. This pin has a four level logic input, centered at 0,  $1/3V_{DD}$ ,  $2/3V_{DD}$  and  $V_{DD}$ . An external resistive divider can be used to set the  $1/3V_{DD}$  and  $2/3V_{DD}$  logic levels. Table 5 shows the logic states for the MODE pin.

Table 5. MODE Pin Function

| MODE        | OUTPUT FORMAT  | CLOCK DUTY CYCLE STABILIZER |
|-------------|----------------|-----------------------------|
| 0V(GND)     | Offset Binary  | Off                         |
| $1/3V_{DD}$ | Offset Binary  | On                          |
| $2/3V_{DD}$ | 2's Complement | On                          |
| $V_{DD}$    | 2's Complement | Off                         |

### Overflow Bit

An overflow output bit (OF) indicates when the converter is overranged or underranged. In CMOS mode, a logic high on the OFA pin indicates an overflow or underflow on the A data bus, while a logic high on the OFB pin indicates an overflow on the B data bus. In LVDS mode, a differential logic high on  $OF^+/OF^-$  pins indicates an overflow or underflow.

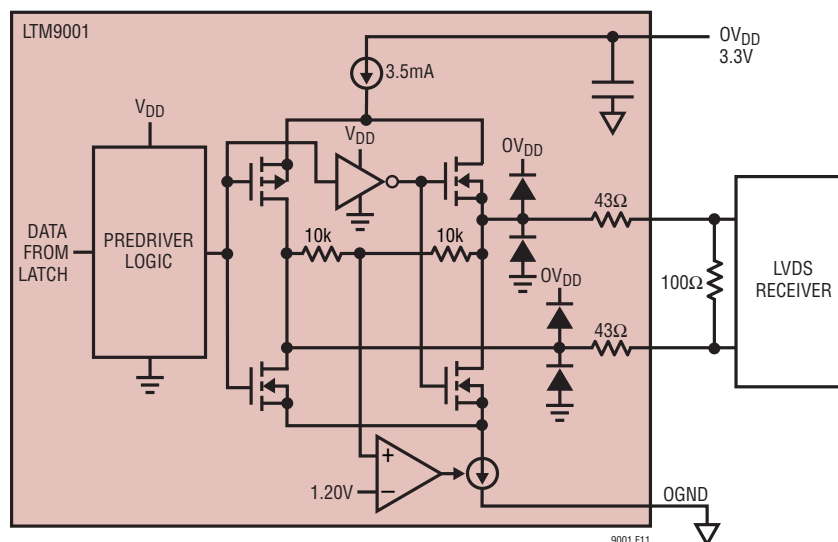


Figure 11. Equivalent Output Buffer in LVDS Mode

## APPLICATIONS INFORMATION

### Output Clock

The ADC has a delayed version of the encode input available as a digital output, CLKOUT. The CLKOUT pin can be used to synchronize the converter data to the digital system. This is necessary when using a sinusoidal encode.

In both CMOS modes, A bus data will be updated as CLKOUTA falls and CLKOUTB rises. In demultiplexed CMOS mode the B bus data will be updated as CLKOUTA falls and CLKOUTB rises.

In full rate CMOS mode, only the A data bus is active; data may be latched on the rising edge of CLKOUTA or the falling edge of CLKOUTB.

In demultiplexed CMOS mode CLKOUTA and CLKOUTB will toggle at 1/2 the frequency of the encode signal. Both the A bus and the B bus may be latched on the rising edge of CLKOUTA or the falling edge of CLKOUTB.

### Digital Output Randomizer

Interference from the ADC digital outputs is sometimes unavoidable. Interference from the digital outputs may be from capacitive or inductive coupling or coupling through the ground plane. Even a tiny coupling factor can result in discernible unwanted tones in the ADC output spectrum.

By randomizing the digital output before it is transmitted off chip, these unwanted tones can be randomized, trading a slight increase in the noise floor for a large reduction in unwanted tone amplitude.

The digital output is “randomized” by applying an exclusive-OR logic operation between the LSB and all other data output bits. To decode, the reverse operation is applied; that is, an exclusive-OR operation is applied between the LSB and all other bits. The LSB, OF and CLKOUT output are not affected. The output randomizer function is active when the RAND pin is high.

### Output Driver Power

Separate output power and ground pins allow the output drivers to be isolated from the analog circuitry. The power supply for the digital output buffers,  $OV_{DD}$ , should be tied to the same power supply as for the logic being driven. For

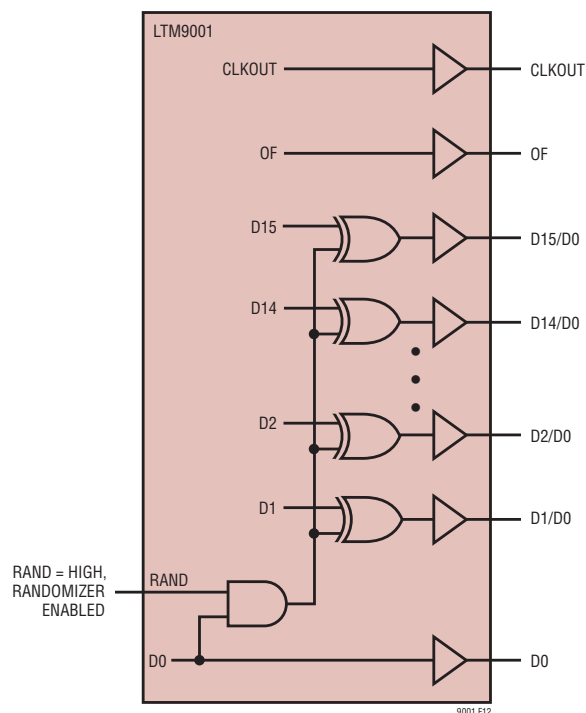


Figure 12. Functional Equivalent of Digital Output Randomizer

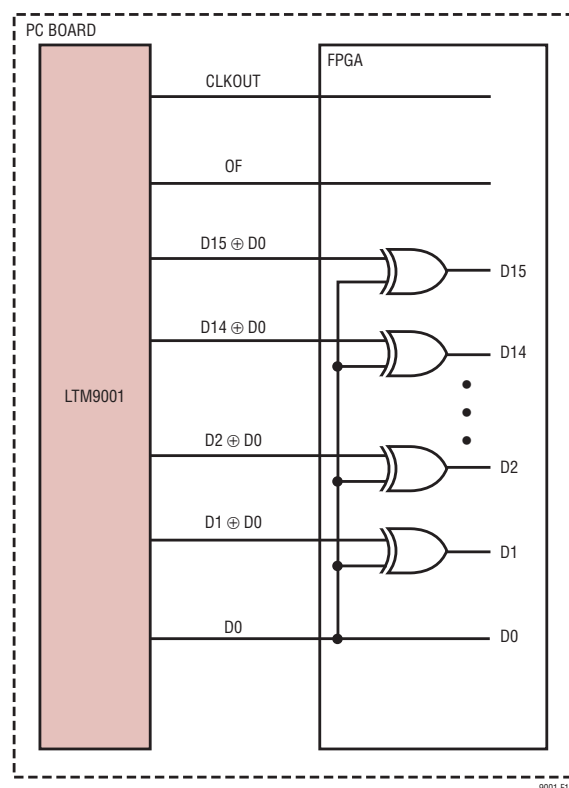


Figure 13. Derandomizing a Randomized Digital Output

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## APPLICATIONS INFORMATION

example, if the converter is driving a DSP powered by a 1.8V supply, then  $OV_{DD}$  should be tied to that same 1.8V supply.  $OV_{DD}$  can be powered with any logic voltage up to the 3.6V.  $OGND$  can be powered with any voltage from ground up to 1V and must be less than  $OV_{DD}$ . The logic outputs will swing between  $OGND$  and  $OV_{DD}$ .

### Internal Dither

The LTM9001 is a 16-bit receiver subsystem with a very linear transfer function; however, at low input levels even slight imperfections in the transfer function will result in unwanted tones. Small errors in the transfer function are usually a result of ADC element mismatches. An optional internal dither mode can be enabled to randomize the input location on the ADC transfer curve, resulting in improved SFDR for low signal levels.

As shown in Figure 14, the output of the sample-and-hold amplifier is summed with the output of a dither DAC. The dither DAC is driven by a long sequence pseudo-random number generator; the random number fed to the dither DAC is also subtracted from the ADC result. If the dither DAC is precisely calibrated to the ADC, very little of the dither signal will be seen at the output. The dither signal that does leak through will appear as white noise. The dither

DAC will cause a small elevation in the noise floor of the ADC, as compared to the noise floor with dither off.

For best noise performance with the dither signal on, the driving impedance connected across pins  $IN^+/IN^-$  should closely match that of the module (see Table 1). A source impedance that is resistive and matches that of the module within 10% will give the best results.

### Supply Sequencing

The  $V_{CC}$  pin provides the supply to the amplifier and the  $V_{DD}$  pin provides the supply to the ADC. The amplifier and the ADC are separate integrated circuits within the LTM9001; however, there are no supply sequencing considerations beyond standard practice. It is recommended that the amplifier and ADC both use the same low noise, 3.3V supply, but the amplifier may be operated from a lower voltage level if desired. Both devices can operate from the same 3.3V linear regulator but place a ferrite bead between the  $V_{CC}$  and  $V_{DD}$  pins. Separate linear regulators can be used without additional supply sequencing circuitry if they have common input supplies.

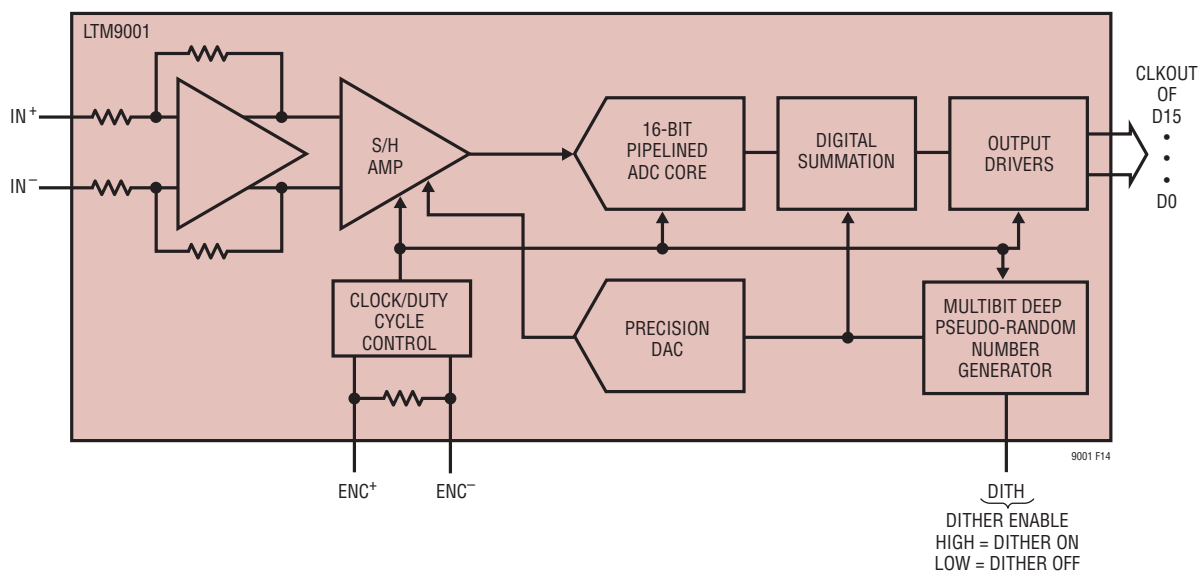


Figure 14. Functional Equivalent Block Diagram of Internal Dither Circuit

## APPLICATIONS INFORMATION

### Grounding and Bypassing

The LTM9001 requires a printed circuit board with a clean unbroken ground plane; a multilayer board with an internal ground plane is recommended. The pinout of the LTM9001 has been optimized for a flow-through layout so that the interaction between inputs and digital outputs is minimized. A continuous row of ground pads facilitate a layout that ensures that digital and analog signal lines are separated as much as possible.

The LTM9001 is internally bypassed with the amplifier ( $V_{CC}$ ) and ADC ( $V_{DD}$ ) supplies returning to a common ground (GND). The digital output supply ( $0V_{DD}$ ) is returned to OGND. Additional bypass capacitance is optional and may be required if power supply noise is significant.

The differential inputs should run parallel and close to each other. The input traces should be as short as possible to minimize capacitance and to minimize noise pickup.

### Heat Transfer

Most of the heat generated by the LTM9001 is transferred through the bottom-side ground pads. For good electrical and thermal performance, it is critical that all ground pins are connected to a ground plane of sufficient area with as many vias as possible.

### Recommended Layout

The high integration of the LTM9001 makes the PC board layout very simple and easy. However, to optimize its electrical and thermal performance, some layout considerations are still necessary, see Figures 15-18.

- Use large PCB copper areas for ground. This helps to dissipate heat in the package through the board and also helps to shield sensitive on-board analog signals. Common ground (GND) and output ground (OGND) are electrically isolated on the LTM9001, but can be connected on the PCB underneath the part to provide a common return path.
- Use multiple ground vias. Using as many vias as possible helps to improve the thermal performance of the board and creates necessary barriers separating analog and digital traces on the board at high frequencies.
- Separate analog and digital traces as much as possible, using vias to create high-frequency barriers. This will reduce digital feedback that can reduce the signal-to-noise ratio (SNR) and dynamic range of the LTM9001.

The quality of the paste print is an important factor in producing high yield assemblies. It is recommended to use a type 3 or 4 printing no-clean solder paste. The solder stencil design should follow the guidelines outlined in Application Note 100.

The LTM9001 employs gold-finished pads for use with Pb-based or tin-based solder paste. It is inherently Pb-free and complies with the JEDEC (e4) standard. The materials declaration is available online at [http://www.linear.com/designtools/leadfree/mat\\_dec.jsp](http://www.linear.com/designtools/leadfree/mat_dec.jsp).

## APPLICATIONS INFORMATION

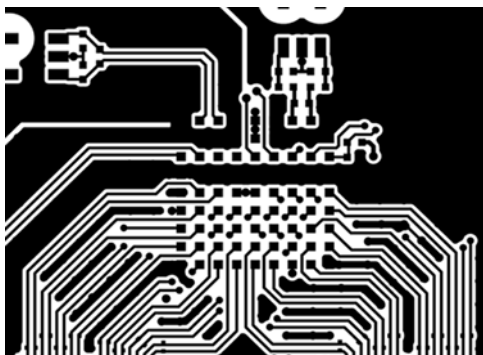


Figure 15. Layer 1



Figure 16. Layer 2

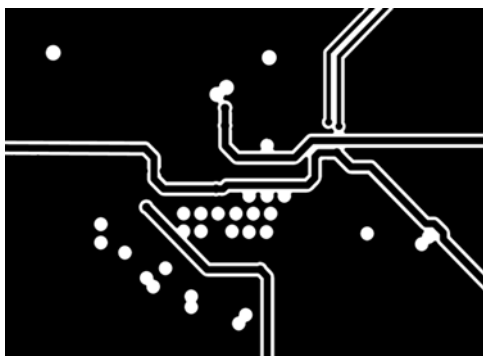


Figure 17. Layer 3

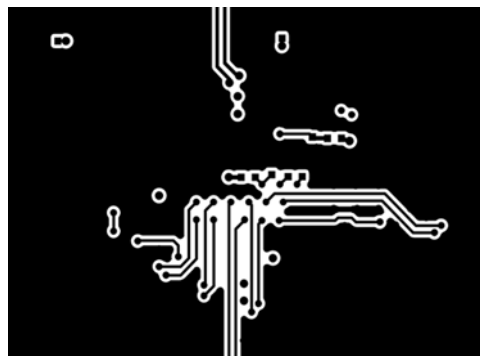
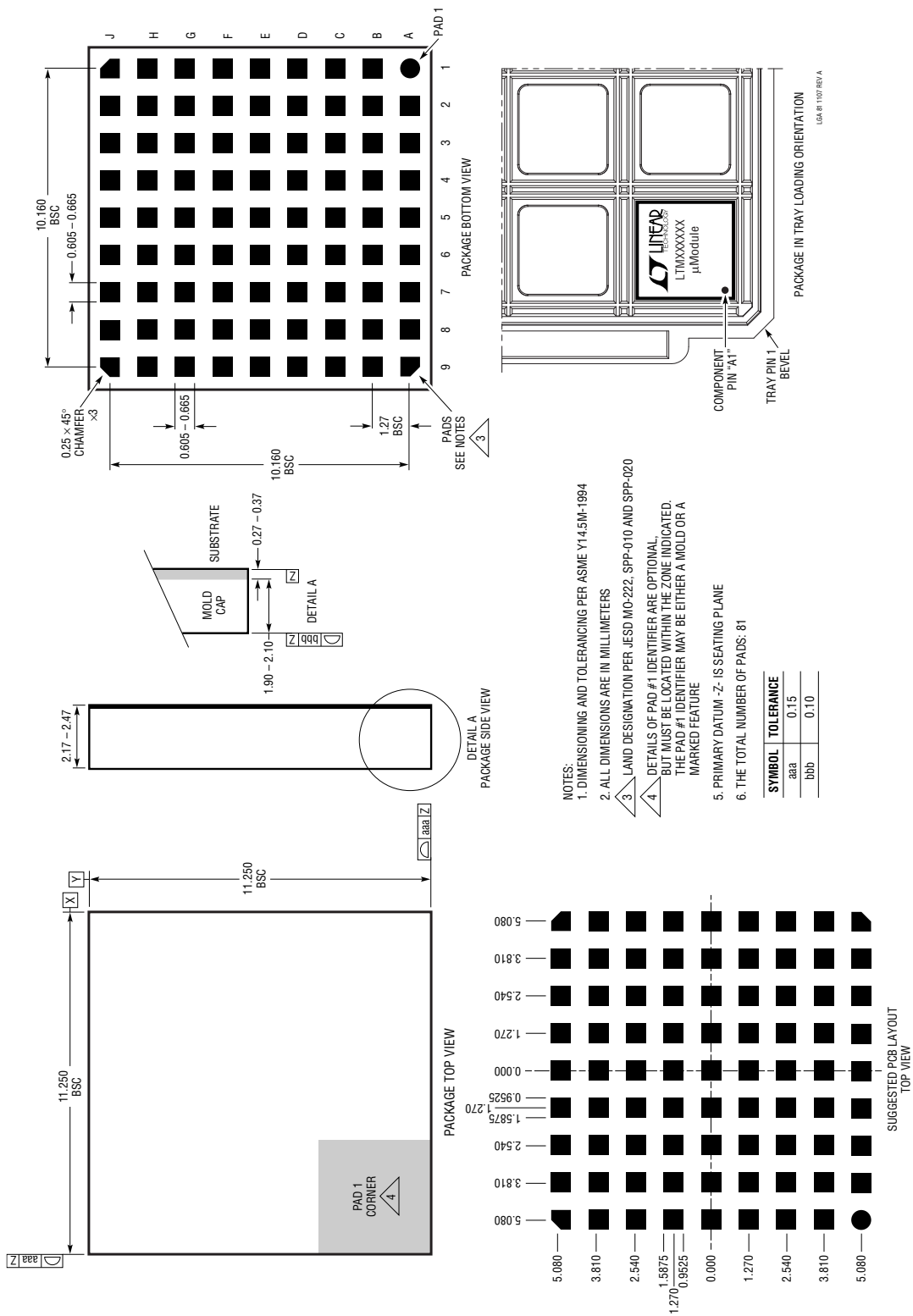


Figure 18. Layer 4

PACKAGE DESCRIPTION

LGA Package  
81-Lead (11.25mm × 11.25mm × 2.32mm)  
(Reference LTC DWG # 05-08-1809 Rev A)



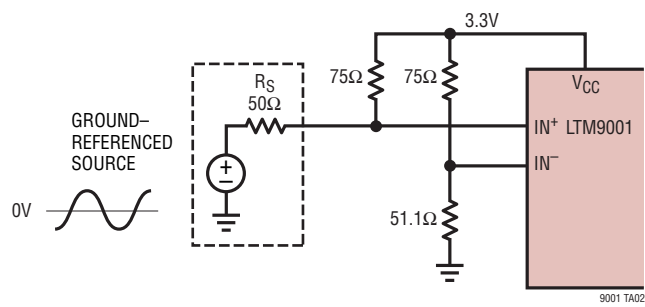
**REVISION HISTORY** (Revision history begins at Rev C)

| REV | DATE | DESCRIPTION                            | PAGE NUMBER |
|-----|------|----------------------------------------|-------------|
| C   | 7/10 | Updated Timing Characteristics section | 6, 7        |

# LTM9001-Ax/LTM9001-Bx

## TYPICAL APPLICATION

### LTM9001 with Ground-Referenced Single-Ended Input



## RELATED PARTS

| PART NUMBER                                    | DESCRIPTION                                                                                                | COMMENTS                                 |
|------------------------------------------------|------------------------------------------------------------------------------------------------------------|------------------------------------------|
| LTC2202                                        | 16-Bit, 10Msps ADC                                                                                         | 140mW, 81.6dB SNR, 100dB SFDR            |
| LTC2203                                        | 16-Bit, 25Msps ADC                                                                                         | 220mW, 81.6dB SNR, 100dB SFDR            |
| LTC2204                                        | 16-Bit, 40Msps ADC                                                                                         | 480mW, 79.1dB SNR, 100dB SFDR            |
| LTC2205                                        | 16-Bit, 65Msps ADC                                                                                         | 610mW, 79dB SNR, 100dB SFDR              |
| LTC2206                                        | 16-Bit, 80Msps ADC                                                                                         | 725mW, 77.9dB SNR, 100dB SFDR            |
| LTC2207                                        | 16-Bit, 105Msps ADC                                                                                        | 900mW, 77.9dB SNR, 100dB SFDR            |
| LTC2208                                        | 16-Bit, 130Msps ADC                                                                                        | 1250mW, 77.7dB SNR, 100dB SFDR           |
| LTC2209                                        | 16-Bit, 160Msps ADC                                                                                        | 1450mW, 77.1dB SNR, 100dB SFDR           |
| LTC6400-8/LTC6400-14/<br>LTC6400-20/LTC6400-26 | Low Noise, Low Distortion Differential Amplifier for 300MHz IF, Fixed Gain of 8dB, 14dB, 20dB or 26dB      | 3V, 90mA, 39.5dBm OIP3 at 300MHz, 6dB NF |
| LTC6401-8/LTC6401-14/<br>LTC6401-20/LTC6401-26 | Low Noise, Low Distortion Differential Amplifier for 140MHz IF, Fixed Gain of 8dB, 14dB, 20dB 20dB or 26dB | 3V, 45mA, 45.5dBm OIP3 at 140MHz, 6dB NF |